

## TRIPLE 10-BIT, 90-MSPS, VIDEO AND GRAPHICS DIGITIZER WITH HORIZONTAL PLL

Check for Samples: TVP70025I

### **FEATURES**

- **Analog Channels** 
  - –6-dB to 6-dB Analog Gain
  - Analog Input Multiplexers (MUXs)
  - Automatic Video Clamp
  - Three Digitizing Channels, Each With Independently Controllable Clamp, Gain, Offset, and Analog-to-Digital Converter (ADC)
  - Clamping: Selectable Clamping Between **Bottom Level and Mid Level**
  - Offset: 1024-Step Programmable RGB or YPbPr Offset Control
  - Gain: 8-Bit Programmable Gain Control
  - ADC: 10-Bit 90-MSPS A/D Converter
  - Automatic Level Control (ALC) Circuit
  - Composite Sync: Integrated Sync-on-Green **Extraction From Green/Luminance Channel**
  - Support for DC- and AC-Coupled Input Signals
  - Programmable Video Bandwidth Control
  - Supports Component Video Standards 480i, 576i, 480p, 576p, 720p, and 1080i
  - Supports PC Graphics Inputs up to 90 **MSPS**
  - Programmable RGB-to-YCbCr Color Space Conversion
- Horizontal Phase-Locked Loop (PLL)
  - Fully Integrated Horizontal PLL for Pixel **Clock Generation**
  - 9-MHz to 90-MHz Pixel Clock Generation From HSYNC Input
  - Adjustable Horizontal PLL Loop Bandwidth for Minimum Jitter
  - 5-Bit Programmable Subpixel Accurate **Positioning of Sampling Phase**

- **Output Formatter** 
  - Supports 20-bit 4:2:2 Outputs With **Embedded Syncs**
  - Support for RGB/YCbCr 4:4:4 and YCbCr 4:2:2 Output Modes to Reduce Board Traces
  - Dedicated DATACLK Output With **Programmable Output Polarity for Easy** Latching of Output Data
- System
  - Industry-Standard Normal/Fast I<sup>2</sup>C Interface With Register Readback Capability
  - Space-Saving 100-Pin TQFP Package
  - Thermally-Enhanced PowerPAD<sup>™</sup> Package for Better Heat Dissipation
  - Industrial Temperature Range –40°C to 85°C

### APPLICATIONS

- LCD TV/Monitors/Projectors
- **DLP TV/Projectors** ٠
- **PDP TV/Monitors**
- LCOS TV/Monitors
- **PCTV Set-Top Boxes**
- **Digital Image Processing** •
- Video Capture/Video Editing
- Scan Rate/Image Resolution Converters ٠
- Video Conferencing •
- **Video/Graphics Digitizing Equipment**



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### DESCRIPTION

The TVP70025I is a complete solution for digitizing video and graphic signals in RGB or YPbPr color spaces. The device supports pixel rates up to 90 MHz. Therefore, it can be used for PC graphics digitizing up to WXGA (1440  $\times$  900) resolution at a 60-Hz screen refresh rate, and in video environments for the digitizing of digital TV formats, including HDTV up to 1080i.

The TVP70025I is powered from 3.3-V and 1.8-V supply and integrates a triple high-performance analog-todigital (A/D) converter with clamping functions and variable gain, independently programmable for each channel. The clamp timing window is provided by an external pulse or can be generated internally. The TVP70025I includes analog slicing circuitry on the SOG inputs to support sync-on-luminance or sync-on-green extraction. In addition, TVP70025I can extract discrete HSYNC and VSYNC from composite sync using a sync slicer.

The TVP70025I also contains a complete horizontal phase-locked loop (PLL) block to generate a pixel clock from the HSYNC input. Pixel clock output frequencies range from 9 MHz to 90 MHz.

All programming of the device is done via an industry-standard I<sup>2</sup>C interface, which supports both reading and writing of register settings. The TVP70025I is available in a space-saving 100-pin TQFP PowerPAD package.

PACKAGED DEVICES <sup>(2)</sup>	PACKAGE OPTION
100-PIN PLASTIC FLATPACK PowerPAD	PACKAGE OF HON
TVP70025IPZP	Tray
TVP70025IPZPR	Reel
	100-PIN PLASTIC FLATPACK PowerPAD TVP70025IPZP

### Table 1. Ordering Information<sup>(1)</sup>

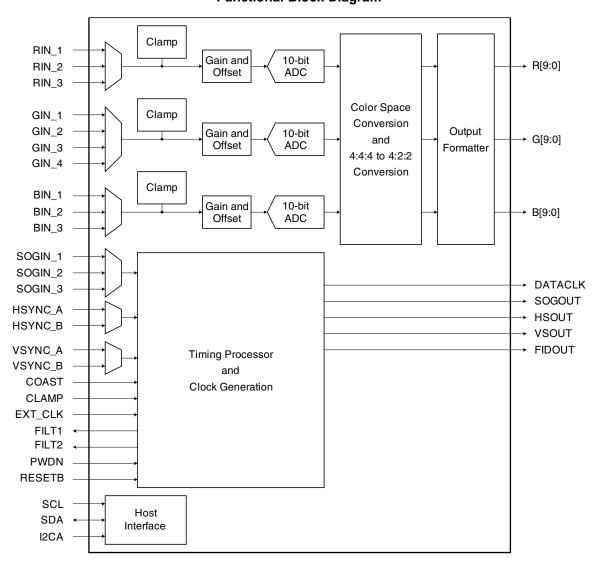
(1) For the most current package and ordering information, see the Package Option Addendum at the end of this document, or see the TI web site at www.ti.com.

(2) Package drawings, thermal data, and symbolization are available at www.ti.com/packaging.

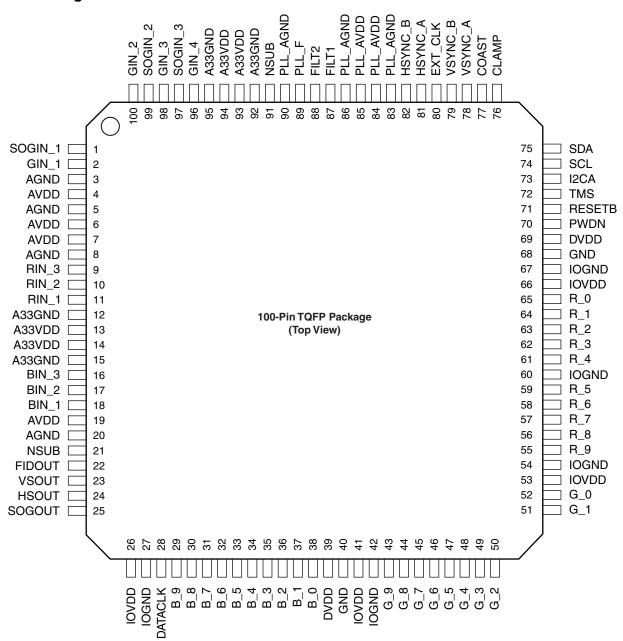


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Functional Block Diagram



### Terminal Assignments



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### Table 2. Terminal Functions

TEI	RMINAL		
NAME	NO.	I/O	DESCRIPTION
Analog Video	I	1	
RIN_111IAnalog video input for R/Pr 1RIN_210IAnalog video input for R/Pr 2RIN_39IAnalog video input for R/Pr 3GIN_12IAnalog video input for G/Y 1GIN_2100IAnalog video input for G/Y 2GIN_398IAnalog video input for G/Y 3GIN_496IAnalog video input for G/Y 4BIN_118IAnalog video input for B/Pb 1BIN_217IAnalog video input for B/Pb 2BIN_316IAnalog video input for B/Pb 3The inputs must be ac coupled. The recommended coupling capacitor is 0.1inputs should be connected to ground using a 10-nF capacitor.		Analog video input for R/Pr 2 Analog video input for R/Pr 3 Analog video input for G/Y 1 Analog video input for G/Y 2 Analog video input for G/Y 3 Analog video input for B/Pb 1 Analog video input for B/Pb 1 Analog video input for B/Pb 2 Analog video input for B/Pb 3 The inputs must be ac coupled. The recommended coupling capacitor is 0.1 µF. Unused analog	
Clock Signals	5	1	
DATACLK	28	0	Data clock output
EXT_CLK	80	I	External clock input. May be used as a timing reference for the mode detection block instead of the internal clock reference. Also may be used as the ADC sample clock instead of the H-PLL generated clock.
Digital Video			
R[9:0] G[9:0] B[9:0]	55–59, 61–65 43-52 29-38	000	Digital video output of R/Cr, R[9] is the most significant bit (MSB). Digital video output of G/Y, G[9] is the MSB. Digital video output of B/Cb, B[9] is the MSB. For 4:2:2 mode, multiplexed CbCr data is output on B[9:0]. Unused outputs can be left unconnected.
Miscellaneou	s Signals		
PWDN	70	I	Power down input 0 = Normal mode 1 = Power down
RESETB	71	I	Reset input, active low. Outputs are placed in a high-impedance mode during reset (see Table 11).
TMS	72	I	Test mode select input, active high. Used to enable scan test mode. For normal operation, connect to ground.
FILT1	87	0	External filter connection for the horizontal PLL. A 0.1- $\mu$ F capacitor in series with a 1.5-k $\Omega$ resistor should be connected from this pin to pin 89 (see Figure 4).
FILT2	88	0	External filter connection for the horizontal PLL. A 4.7-nF capacitor should be connected from this pin to pin 89 (see Figure 4).
PLL_F	89	Ι	Horizontal PLL filter internal supply connection
Host Interface	9		
I2CA	73	Ι	$I^2C$ slave address input. The $I^2C$ slave address must be configured with an external pullup or pulldown resistor (see Table 10). 0 = Slave address = B8h 1 = Slave address = BAh
SCL	74	I	I <sup>2</sup> C clock input
SDA	75	I/O	I <sup>2</sup> C data bus

TERMINAL

10	Table 2. Terminal Functions (continued)		
I/O	DESCRIPTION		

NAME	NO.	1/0	DESCRIPTION	
Power Supplie	S		·	
NSUB	21, 91	I	Substrate ground. Connect to analog ground.	
A33VDD	13, 14, 93, 94	I	Analog power. Connect to 3.3 V.	
A33GND	12, 15, 92, 95	I	Analog 3.3-V return. Connect to ground.	
AGND	3, 5, 8, 20	I	Analog 1.8-V return. Connect to ground.	
AVDD	4, 6, 7, 19	I	Analog power. Connect to 1.8 V.	
PLL_AVDD	84, 85	I	PLL analog power. Connect to 1.8 V.	
PLL_AGND	83, 86, 90	I	PLL analog power return. Connect to ground.	
DGND	40, 68	I	Digital return. Connect to ground.	
DVDD	39, 69	I	Digital power. Connect to 1.8 V.	
IOGND	27, 42, 54, 60, 67	I	Digital power return. Connect to ground.	
IOVDD	26, 41, 53, 66	Ι	Digital power. Connect to 3.3 V or less for reduced noise.	
Sync Signals				
CLAMP	76	I	External clamp input. Unused inputs can be connected to ground.	
COAST	77	I	External PLL COAST signal input. Unused inputs can be connected to ground.	
VSYNC_A VSYNC_B	78 79	I	Vertical sync input A Vertical sync input B Unused inputs can be connected to ground.	
HSYNC_A HSYNC_B	81 82	1	Horizontal sync input A Horizontal sync input B Unused inputs can be connected to ground.	
SOGIN_1 SOGIN_2 SOGIN_3	1 99 97	   	Sync-on-green input 1 Sync-on-green input 2 Sync-on-green input 3 Unused inputs should be connected to ground using a 1-nF capacitor.	
FIDOUT	22	0	Field ID output. Using register 17h, this pin also may be programmed to be the internal sync processing REFCLK output, coast output, clamp pulse output, or data enable.	
VSOUT	23	0	Vertical sync output	
HSOUT	24	0	Horizontal sync output	
SOGOUT	25	0	Sync-on-green slicer output	

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### Absolute Maximum Ratings<sup>(1)</sup>

over operating free-air temperature range (unless otherwise noted)

Supply voltage range	IOVDD to IOGND	–0.5 V to 4.5 V		
	DVDD to DGND	–0.5 V to 2.3 V		
	PLL_AVDD to PLL_AGND and AVDD to AGND	–0.5 V to 2.3 V		
	A33VDD to A33GND	–0.5 V to 4.5 V		
Digital input voltage range	V <sub>1</sub> to DGND	–0.5 V to 4.5 V		
Analog input voltage range	A <sub>I</sub> to A33GND	–0.2 V to 2.3 V		
Digital output voltage range	V <sub>O</sub> to DGND	–0.5 V to 4.5 V		
Operating free-air temperature range		-40C to 85°C		
Storage temperature range	Storage temperature range			
	Supply voltage range Digital input voltage range Analog input voltage range Digital output voltage range Operating free-air temperature	Supply voltage range       IOVDD to IOGND         DVDD to DGND       DVDD to DGND         PLL_AVDD to PLL_AGND and AVDD to AGND         A33VDD to A33GND         Digital input voltage range       V1 to DGND         Analog input voltage range       A1 to A33GND         Digital output voltage range       V0 to DGND         Operating free-air temperature range       V0		

(1) Stresses beyond those listed under Absolute Maximum Ratings may cause permanent damage to the device. These are stress ratings only and functional operation of the device at these or any other conditions beyond those indicated under Recommended Operating Conditions is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

### **Recommended Operating Conditions**

		MIN	NOM	MAX	UNIT
IOVDD	Digital I/O supply voltage	3	3.3	3.6	V
DVDD	Digital supply voltage	1.7	1.8	1.95	V
PLL_AVDD	Analog supply voltage for horizontal PLL	1.7	1.8	1.95	V
AVDD	Analog supply voltage	1.7	1.8	1.95	V
A33VDD	Analog supply voltage	3	3.3	3.6	V
V <sub>I(PP)</sub>	Analog input voltage (ac coupling necessary)	0.5		2	V
V <sub>IH</sub>	Digital input voltage high	0.7 IOVDD			V
V <sub>IL</sub>	Digital input voltage low			0.3 IOVDD	V
I <sub>OH</sub>	High-level output current			2	mA
I <sub>OL</sub>	Low-level output current			-2	mA
IOH_DATACLK	DATACLK high-level output current			4	mA
I <sub>OL_DATACLK</sub>	DATACLK low-level output current			-4	mA
	ADC conversion rate	9		90	MHz
T <sub>A</sub>	Operating free-air temperature	-40		85	°C

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### **Electrical Characteristics**

IOVDD = 3.3 V, DVDD = 1.8 V, PLL\_AVDD = 1.8 V, AVDD = 1.8 V, A33VDD = 3.3 V,  $T_A = 25^{\circ}C$ 

	PARAMETER	TEST CONDITIONS	TYP <sup>(1)</sup>	TYP <sup>(2)</sup>	UNIT
Power Sup	ply		•		
I <sub>A33VDD</sub>	3.3-V supply current	480p (27 MSPS)	43	43	mA
IIOVDD	3.3-V supply current	480p (27 MSPS)	11	14	mA
I <sub>AVDD</sub>	1.8-V supply current	480p (27 MSPS)	168	170	mA
I <sub>PLL_VDD</sub>	1.8-V supply current	480p (27 MSPS)	11	11	mA
I <sub>DVDD</sub>	1.8-V supply current	480p (27 MSPS)	10	12	mA
P <sub>TOT</sub>	Total power dissipation, normal mode	480p (27 MSPS)	518	535	mW
I <sub>A33VDD</sub>	3.3-V supply current	WXGA (85.5MSPS)	70	70	mA
IIOVDD	3.3-V supply current	WXGA (85.5 MSPS)	35	60	mA
I <sub>AVDD</sub>	1.8-V supply current	WXGA (85.5 MSPS)	195	200	mA
I <sub>PLL_VDD</sub>	1.8-V supply current	WXGA (85.5 MSPS)	20	20	mA
I <sub>DVDD</sub>	1.8-V supply current	WXGA (85.5 MSPS)	30	40	mA
P <sub>TOT</sub>	Total power dissipation, normal mode	WXGA (85.5 MSPS)	787	897	mW
P <sub>DOWN</sub>	Total power dissipation, power-down mode		15	15	mW

SMPTE color bar RGB input pattern used.
 Multi-burst input pattern used.



### **Electrical Characteristics**

IOVDD = 3.3 V, DVDD = 1.8 V, PLL\_AVDD = 1.8 V, AVDD = 1.8 V, A33VDD = 3.3 V,  $T_A = -40^{\circ}C$  to 85°C (unless otherwise noted)

	PARAMETER	TEST CONDITIONS	MIN	TYP	MAX	UNIT
Analog Int	erface					
	Input voltage range	By design	0.5	1	2	V <sub>pp</sub>
ZI	Input impedance, analog video inputs	By design		500		kΩ
Digital Log	gic Interface					
CI	Input capacitance	By design		10		pF
ZI	Input impedance	By design		500		kΩ
V <sub>OH</sub>	Output voltage high	I <sub>OH</sub> = 2 mA	0.8 IOVDD			V
V <sub>OL</sub>	Output voltage low	$I_{OL} = -2 \text{ mA}$			0.2 IOVDD	V
V <sub>OH_SCLK</sub>	DATACLK output voltage high	I <sub>OH</sub> = 4 mA	0.8 IOVDD			V
V <sub>OL_SCLK</sub>	DATACLK output voltage low	$I_{OH} = -2 \text{ mA}$			0.2 IOVDD	V
V <sub>IH</sub>	High-level input voltage	By design	0.7 IOVDD			V
V <sub>IL</sub>	Low-level input voltage	By design			0.3 IOVDD	V
A/D CONV	ERTERS					
	ADC full-scale input range	Clamp disabled	0.95	1	1.05	V <sub>pp</sub>
	ADC resolution	10-bit range			10	bits
DNL	DC differential nonlinearity	10 bit, 90 MHz	-1	±0.5	+1	LSB
INL	DC integral nonlinearity	10 bit, 90 MHz	-4	±1	+4	LSB
	Missing code	10 bit, 90 MHz		none		
SNR	Signal-to-noise ratio	10 MHz, 1 V <sub>PP</sub> at 90 MSPS		55		dB
	Analog 3-dB bandwidth	By design (W/O LPF) BW select [3:0] = 0h	350	500		MHz
Horizontal	PLL		*			
	Phase adjustment			11.6		degree
	VCO frequency range		9		90	MHz
Analog A	0C Channel					
	Coarse gain full-scale control range	Gain control value $N_G = 15$		±6		dB
	Coarse offset full-scale control range	Referred to 10-bit ADC output		±124		counts
	Coarse offset step size	Referred to 10-bit ADC output		4		counts
Sync Proc	essing					
	Internal clock reference frequency		5	6.5	7	MHz

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### **Timing Requirements**

		1				
	PARAMETER	TEST CONDITIONS <sup>(1)</sup>	MIN	TYP	MAX	UNIT
Cloc	ks, Video Data, Sync Timing					
	Positive duty cycle, DATACLK (CLK POL = 0)		48	50	52	%
	Positive duty cycle, DATACLK (CLK POL = 1)		41	44	45	%
t1	DATACLK rise time	10% to 90%		1.2		ns
t2	DATACLK fall time	90% to 10%		1.2		ns
t3	R, G, B, HSOUT Output delay time		0		2	ns

(1) Measured at 90 MHz with 22-Ω series termination resistor and 10-pF load. Specified by characterization only. Data is clocked out on the rising edge of DATACLK with Reg 18h CLK POL=0 and is clocked out on the falling edge of DATACLK with CLK POL=1.

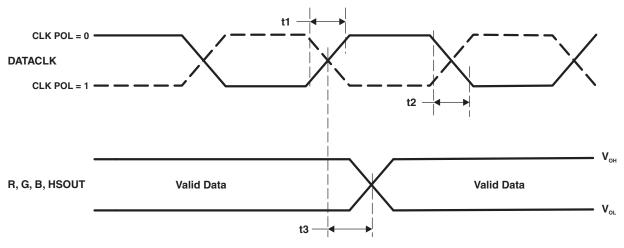


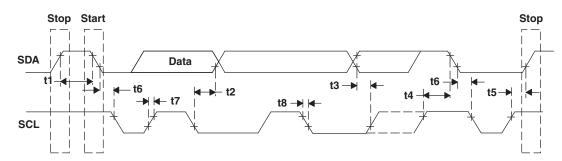
Figure 1. Clock, Video Data, and HSOUT Timing

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	PARAMETER	TEST CONDITIONS	MIN	TYP	MAX	UNIT
I <sup>2</sup> C Ho	st Port		*			
t1	Bus free time between Stop and Start	Specified by design	1.3			μs
t2	Setup time for a (repeated) Start condition	Specified by design	0.6			μs
t3	Hold time (repeated) Start condition	Specified by design	0.6			μs
t4	Setup time for a Stop condition	Specified by design	0.6			ns
t5	Data setup time	Specified by design	100			ns
t6	Data hold time	Specified by design	0	0.9		μs
t7	Rise time, SDA and SCL signal	Specified by design		250		ns
t8	Fall time, SDA and SCL signal	Specified by design		250		ns
C <sub>b</sub>	Capacitive load for each bus line	Specified by design		400		pF
f <sub>I2C</sub>	I <sup>2</sup> C clock frequency	Specified by design		400		kHz





### **Thermal Characteristics**

	PARAMETER	TEST CONDITIONS <sup>(1)</sup>	MIN	ТҮР	MAX	UNIT
$\theta_{JA}$	Junction-to-ambient thermal resistance, still air	Thermal pad soldered to 4-layer High-K PCB		17.28		°C/W
$\theta_{\text{JC}}$	Junction-to-case thermal resistance, still air	Thermal pad soldered to 4-layer High-K PCB		0.154		°C/W
T <sub>J(MAX)</sub>	Maximum junction temperature for reliable operation				110	°C

(1) Exposed thermal pad must be soldered to JEDEC High-K PCB with adequate ground plane. If split ground planes are used, connect the thermal pad to the digital ground plane.



### FUNCTIONAL DESCRIPTION

### Analog Channel

The TVP70025I contains three identical analog channels that are independently programmable. Each channel consists of a clamping circuit, programmable gain control, programmable offset control, and an A/D converter.

### Analog Input Switch Control

TVP70025I has three analog channels that accept up to ten video inputs. The user can configure the internal analog video switches via the I<sup>2</sup>C interface. The ten analog video inputs can be used for different input configurations, some of which are:

- Up to three SDTV, EDTV, or HDTV component video inputs (limited by number of SOG inputs)
- Up to two 5-wire PC graphics inputs (limited by number of HSYNC and VSYNC inputs)

The input selection is performed by the input select register at I<sup>2</sup>C subaddress 19h a 1Ah (see Input Mux Select 1 and Input Mux Select 2).

### Supported Video Formats

The TVP70025I supports A/D conversion of SDTV (480i, 576i), EDTV (480p, 576p), and HDTV YPbPr component video inputs up to 74.25 MSPS. The TVP70025I also supports A/D conversion and color space conversion of all standard PC graphics formats (RGB) from VGA up to UXGA. The internal sync separator provides support for field rates (VSYNC frequencies) at or above 40 Hz. Separated VSYNC or an external sync separator must be used to support formats having field rates less than 40 Hz. A summary of the analog video standards supported by the TVP70025I is show in Table 3.

VIDEO FORMAT	VIDEO STANDARDS
SDTV (YPbPr Component)	480i, 576i
EDTV (YPbPr Component)	480p, 576p
HDTV (YPbPr Component)	720p50, 720p60, 1080i50, 1080i60
PC graphics (RGB Component)	VGA - XGA 75Hz, WXGA
SCART (RGB Component)	576i

### Table 3. Analog Video Standards

### Analog Input Clamping

The TVP70025I provides dc restoration for all analog video inputs including the SOG slicer inputs. The dc restoration circuit (a.k.a. clamp circuit) restores the ac-coupled video signal to a fixed dc level. One dc restoration circuit is implemented prior to each of the three A/D converters, and a fourth one is located prior to the SOG slicer. The dc restoration circuit can be programmed to operate as either a sync-tip clamp (a.k.a. coarse clamp) or a back-porch clamp (a.k.a. fine clamp). The sync-tip clamp always clamps the video sync-tip level near the bottom of the A/D converter range. The back-porch type clamp supports two clamping levels (bottom level and mid level) that are selectable using bits 0, 1, and 2 of register 10h. When using the fine bottom-level clamp, an optional 300-mV common-mode offset may be selected using bit 7 of register 2Ah.

In general, the analog video input being used for horizontal synchronization purposes should always use the sync-tip clamp; all other analog video inputs should use the back-porch clamp. The advantage of the back-porch clamp is that it has negligible video droop or tilt across a video line.



The selection between bottom- and mid-level clamping is performed by I<sup>2</sup>C subaddress 10h (see the Sync-On-Green Threshold section). The fine clamps also must be enabled via I<sup>2</sup>C register 2Ah for proper operation. The internal clamping time can be adjusted using the I<sup>2</sup>C clamp start and width registers at subaddress 05h and 06h, respectively (see Clamp Start and Clamp Width).

VIDEO MODE	SOG INPUT (Y/G)	GREEN ADC CHANNEL (Y/G)	RED ADC CHANNEL (Pr/R)	BLUE ADC CHANNEL (Pb/B)
YPbPr Component	Coarse	Fine Bottom Level	Fine Mid Level	Fine Mid Level
PC Graphics	Coarse	Fine Bottom Level	Fine Bottom Level	Fine Bottom Level
SCART-RGB	Coarse	Fine Bottom Level	Fine Bottom Level	Fine Bottom Level

Table 4. Recommended	d Clamp	Setting b	y Video Mode
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A single-pole low-pass filter with three selectable cutoff frequencies (0.5, 1.7, and 4.8 MHz) is implemented in the feedback loop of the sync-tip clamp circuit.

#### Programmable Gain Control

The TVP70025I provides a 4-bit coarse analog gain control (before A/D conversion) and an 8-bit fine digital gain control (after A/D conversion). The coarse analog gain and the fine digital gain are both independently programmable for each ADC channel.

### Coarse Gain Control

The 4-bit coarse analog gain control has a 4:1 linear gain control range defined by the following equation.

Coarse Gain =  $0.5 + N_{CG}/10$ , where  $0 \le N_{CG} \le 15$  $0.5 \le \text{Coarse Gain} \le 2.0$ Default:  $N_{CG} = 7$  (Coarse Gain = 1.2)

The 4-bit coarse gain control can scale a signal with a voltage-input compliance of 0.5  $V_{PP}$  to 2  $V_{PP}$  to a full-scale 10-bit A/D output code range. The minimum gain corresponds to a code 0h (2- $V_{PP}$  full-scale input, –6-dB gain) while the maximum gain corresponds to code Fh (0.5- $V_{PP}$  full scale, +6-dB gain). The 4-bit coarse gain control is independently controllable for each ADC channel (Red Coarse Gain, Green Coarse Gain, and Blue Coarse Gain).

### Fine Gain Control

The 8-bit fine digital gain control has a 2:1 linear gain control range defined by the following equation.

Fine Gain =  $1.0 + N_{FG}/256$  where  $0 \le N_{FG} \le 255$  $1.0 \le$  Fine Gain < 2.0Default:  $N_{FG} = 0$  (Fine Gain = 1.0)

The 8-bit fine gain control is independently controllable for each ADC channel (Red Fine Gain, Green Fine Gain, and Blue Fine Gain). For a normal PC graphics input, the fine gain is used mostly.

#### Programmable Offset Control

The TVP70025I provides a 6-bit coarse analog offset control (before A/D conversion) and a 10-bit fine digital offset control (after A/D conversion). The coarse analog offset and the fine digital offset are both independently programmable for each ADC channel.

#### Coarse Offset Control

A 6-bit code sets the coarse offset (Red Coarse Offset, Green Coarse Offset, Blue Coarse Offset) with individual adjustment per channel. The coarse offset ranges from -32 counts to +31 counts. The coarse offset registers apply before the ADC.

### Fine Offset Control

A 10-bit fine offset registers (Red Fine Offset, Green Fine Offset, Blue Fine Offset) apply after the ADC. The fine offset ranges from –512 counts to +511 counts.



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### Automatic Level Control (ALC)

The ALC circuit maintains the level of the signal to be set at a value that is programmed at the fine offset  $I^2C$  register. It consists of a pixel averaging filter and feedback loop. This ALC function can be enabled or disabled by the  $I^2C$  register at subaddress 26h.

The ALC circuit needs a timing pulse generated internally but the user should program the position properly. The ALC pulse must be positioned after the clamp pulse. The position of ALC pulse is controlled by ALC placement I<sup>2</sup>C register at address 31h. This is available only for internal ALC pulse timing. When using an external clamp pulse, the fine clamp and the ALC both start on the leading edge of the external clamp pulse. Therefore, it is recommended to keep the external clamp pulse as long as possible.

### Analog-to-Digital Converters (ADCs)

All ADCs have a resolution of 10 bits and can operate up to 90 MSPS. All A/D channels receive an identical clock from the on-chip phase-locked loop (PLL) at a frequency between 12 MHz and 90 MHz. All ADC reference voltages are generated internally. The external sampling clock also can be used.

### **Horizontal PLL**

The horizontal PLL generates a high-frequency internal clock used by the ADC sampling and data clocking out to derive the pixel output frequency with programmable phase. The reference signal for this PLL is the horizontal sync signal supplied on the HSYNC input or from extracted horizontal sync of the sync slicer block for embedded sync signals. The horizontal PLL consists of a phase detector, charge pump, loop filter, voltage controlled oscillator (VCO), phase select, feedback divider, and post divider. The horizontal PLL block diagram is shown in Figure 3.

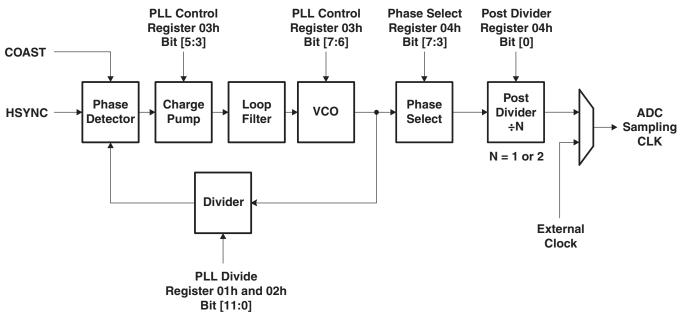


Figure 3. Horizontal PLL Block Diagram

The COAST signal is used to allow the H-PLL to keep running at the same frequency, in the absence of the incoming HSYNC signal or disordered HSYNC period. This is useful during the vertical sync period, or any other time that the HSYNC is not available. The fine clamp is disabled during the H-PLL coast interval.

There are several PLL controls to produce the correct sampling clock. The 12-bit feedback divider register is programmable to select exact multiplication number to generate the pixel clock in the range of 12 MHz to 90 MHz. The 3-bit loop filter current control register is to control the charge pump current that drives the low-pass loop filter. The applicable current values are listed in Table 5.



The purpose of the 2-bit VCO range control is to improve the noise performance of the TVP70025I. The frequency ranges for the VCO are shown in Table 5. The phase of the ADC sample clock generated by the horizontal PLL can be accurately controlled in 32 uniform steps over a single clock period (360/32 = 11.25 degrees phase resolution) using the phase select register located at subaddress 04h.

The horizontal PLL characteristics are determined by the loop filter design, the PLL charge pump current, and the VCO range setting. The loop filter design is shown in Figure 4. Supported settings of VCO range and charge pump current for VESA standard display modes are listed in Table 5.

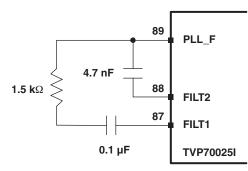


Figure 4. Horizontal PLL Loop Filter

In addition to sourcing the ADC sample clock from the horizontal PLL, an external pixel clock can be used (from pin 80).

STANDARD	RESOLUTION	FRAME RATE (Hz)	LINE RATE (kHz)	PIXEL RATE (MHz)	PLL DIVIDER TOTAL PIX/LINE	PLLDIV [11:4] REG 01h [7:0]	PLLDIV [3:0] REG 02h [7:4]	REG 03h	OUTPUT DIVIDER REG 04h [0]	VCO RANGE REG 03h [7:6]	CP CURRENT REG 03h [5:3]
	640 × 480	59.94	31.469	25.175	800	32h	00h	20h	0	ULow (00b)	100b
VGA	640 × 480	72.809	37.861	31.5	832	34h	00h	20h	0	ULow (00b)	100b
VGA	640 × 480	75	37.5	31.5	840	34h	80h	20h	0	ULow (00b)	100b
	640 × 480	85.008	43.269	36	832	34h	00h	60h	0	Low (01b)	100b
	800 × 600	56.25	35.156	36	1024	40h	00h	58h	0	Low (01b)	011b
	800 × 600	60.317	37.879	40	1056	42h	00h	58h	0	Low (01b)	011b
SVGA	800 × 600	72.188	48.077	50	1040	41h	00h	58h	0	Low (01b)	011b
	800 × 600	75	46.875	49.5	1056	42h	00h	58h	0	Low (01b)	011b
	800 × 600	85.061	53.674	56.25	1048	41h	80h	58h	0	Low (01b)	011b
	1024 × 768	60.004	48.363	65	1344	54h	00h	58h	0	Low (01b)	011b
XGA	1024 ×768	70.069	56.476	75	1328	53h	00h	A8h	0	Med (10b)	101b
	1024 × 768	75.029	60.023	78.75	1312	52h	00h	A8h	0	Med (10b)	101b
	1280 × 768	59.995	47.396	68.25	1440	5Ah	00h	50h	0	Low (01b)	010b
WXGA	1280 × 768	59.87	47.776	79.5	1664	68h	00h	A0h	0	Med (10b)	100b
	1440 x 900	59.01	55.469	88.75	1600	64h	00h	A0h	0	Med (10b)	100b
	720 × 480i	29.97	15.734	13.5	858	35h	A0h	18h	0	ULow (00b)	011b
	720 × 576i	25	15.625	13.5	864	36h	00h	18h	0	ULow (00b)	011b
	720 × 480p	59.94	31.469	27	858	35h	A0h	18h	0	ULow (00b)	011b
) (i de e	720 × 576p	50	31.25	27	864	36h	00h	18h	0	ULow (00b)	011b
Video	1280 × 720p	60	45	74.25	1650	67h	20h	A0h	0	Med (10b)	100b
	1280 × 720p	50	37.5	74.25	1980	7Bh	C0h	98h	0	Med (10b)	011b
	1920 × 1080i	30	33.75	74.25	2200	89h	80h	98h	0	Med (10b)	011b
	1920 × 1080i	25	28.125	74.25	2640	A5h	00h	90h	0	Med (10b)	010b

#### Table 5. Recommended VCO Range and Charge Pump Current Settings for Supporting Standard Display Formats



#### **RGB-to-YCbCr Color Space Conversion**

The TVP70025I supports RGB-to-YCbCr color space conversion (CSC) with  $I^2C$  programmable coefficients. The TVP70025I should default to the CSC coefficients required for HDTV component video inputs. The TVP70025I supports the ability to bypass the CSC block and defaults to the bypass mode (bit 3of subaddress 23h).

RGB-to-YCbCr CSC coefficients for HDTV component video (see CEA-770.3-C, ITU-R BT.709) (default coefficients):

	G'	В'	R'			
Y	00000016E3	00000024F	0000006CE			
Pb	FFFFFF3AB	0000001000	FFFFFFC55			
Pr	FFFFFF178	FFFFFFE88	000001000			
	-YCbCr CSC coeff ative only):	icients for SDTV	component video (see	CEA-770.2-C,	ITU-R	BT.601)
	G'	В'	R'			
Y	00000012C9	0000003A6	000000991			
Pb	FFFFFF566	0000001000	FFFFFFA9A			
Pr	FFFFFF29A	FFFFFFD66	0000001000			

### 4:4:4 to 4:2:2 Conversion

### NOTE

- Selection between the 30-bit 4:4:4 output format and the 20-bit 4:2:2 output format is made using bit 1 of register 15h.
- Multiplexed CbCr data is output on BOUT [9:0] in the 20-bit 4:2:2 output format.
- 4:4:4 to 4:2:2 conversion is implemented after RGB-to-YCbCr color space conversion.



### Sync Processing

The TVP70025I provides two HSYNC inputs and three analog SOG inputs for HDTV and PC graphics inputs. The sync input used by the horizontal PLL is automatically selected based on activity detection.

### Sync Slicer

TVP70025I includes a circuit that compares the input signal on Green channel to a level 150 mV (typical value) above the clamped level (sync tip). The slicing level is programmable by I<sup>2</sup>C register subaddress at 10h. The digital output of the composite sync slicer is available on the SOGOUT pin.

### Noise Immunity

In general, noise on a slowly varying input signal (i.e., sync falling edge) may cause a voltage comparator to false trigger as the input passes through the linear range of the comparator. To improve the overall performance of the TVP70025I sync slicer in the presence of noise on the SOG input, the voltage comparator includes hysteresis. Maintaining a 50% slice level using the I<sup>2</sup>C programmable slice level control can further improve the noise immunity of the Sync slicer. The slice level is programmable in 11.2-mV increments over a 350-mV range as follows.

slice\_level =  $(350 \text{ mV}) \times (N_{TH}/31)$ where  $0 \le N_{TH} \le 31$ , default: 11  $0 \le$  slice\_level  $\le 350 \text{ mV}$ 

### **Glitch Immunity**

During white-to-black transitions, the input video waveform may undershoot below the sync slicer threshold. To help attenuate the amplitude of such glitches, a single-pole low-pass filter with three selectable cutoff frequencies (2.5, 10, and 33 MHz) is provided at the input of the SOG voltage comparator circuit. This filter is bypassed in the default mode.

#### NOTE

Although the low-pass filter may attenuate the amplitude of glitches present on the SOG input, it also makes the sync falling edge less sharp.

### Sync Separator

The sync separator automatically extracts VSYNC and HSYNC from the sliced composite sync input supplied at the SOG input. The G or Y input containing the composite sync must be ac coupled to the SOG input pin using a 1-nF capacitor. Support for PC graphics, SDTV, EDTV, and HDTV is provided. The internal sync separator provides support for formats having field rates (VSYNC frequencies) at or above 40 Hz. An external sync separator or separated VSYNC must be used for field rates less than 40 Hz.

#### Sync Activity Detection

The TVP70025I provides activity detection on the sync inputs (VSYNC, HSYNC) to enable the host processor to determine whether the PC graphics source is configured as a 3-wire, 4-wire, or 5-wire interface as defined here:

- 5 wire (G, B, R, HSYNC, VSYNC)
- 4 wire (G, B, R, CSYNC)
- 3 wire (G, B, R with SOG)

If activity is detected on the VSYNC input, the host processor should assume that the PC graphics input is a standard 5-wire interface. In this case, the HSYNC input of the TVP70025I should be configured as an HSYNC input. If AHSO and AVSO are set for automatic selection in I<sup>2</sup>C Reg 0Eh, the TVP70025I automatically uses the HSYNC and VSYNC inputs, provided signals are present at both inputs.



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If activity is detected on the HSYNC input but not on the VSYNC input, the host processor should assume that the PC graphics input is a standard 4-wire interface. In this case, the HSYNC input of the TVP70025I should be used as a digital CSYNC input. If AHSO and AVSO are set for automatic selection, VSYNC is properly decoded from the CSYNC input, provided no signal is present at the VSYNC input pin. Some test sources output CSYNC on both the HSYNC pin and the VSYNC pin. In this case, the active VSYNC source (AVSS) must be manually set to Sync separated VSYNC in Reg 0Eh. The TVP70025I supports the following two types of CSYNC inputs.

CSYNC = VSYNC XOR HSYNC (default)

#### CSYNC = VSYNC OR HSYNC

If activity is not detected on either the HSYNC input or the VSYNC input, the host processor should assume that the PC graphics input is a standard 3-wire interface. With AHSO and AVSO set for automatic selection and no signals present at the HSYNC and VSYNC input pins, the TVP70025I automatically selects the SOG input as the sync source.

VSYNC INPUT ACTIVITY DETECT	HSYNC INPUT ACTIVITY DETECT	PC GRAPHICS INPUT TYPE
1	1	5 wire (default)
1	0	Undefined (assume 5 wire)
0	1	4 wire
0	0	3 wire

The activity detection status for the VSYNC and HSYNC inputs is written to the I<sup>2</sup>C status register at subaddress 14h.

#### NOTE

Pin 13 of a standard 15-pin VGA video connector can be either a horizontal sync (HSYNC) or a composite sync (CSYNC).

#### NOTE

For component video inputs, the active HSYNC and VSYNC should always be derived from the selected SOG input. This can most easily be ensured by setting the AHSO, AVSO, AHSS and AVSS bit fields in register 0Eh to logic 1.

#### NOTE

For proper operation when separate HSYNC and VSYNC inputs are used, the leading edge of VSYNC must not be precisely aligned with the leading edge of HSYNC. A simple RC delay circuit provides adequate delay in most applications.



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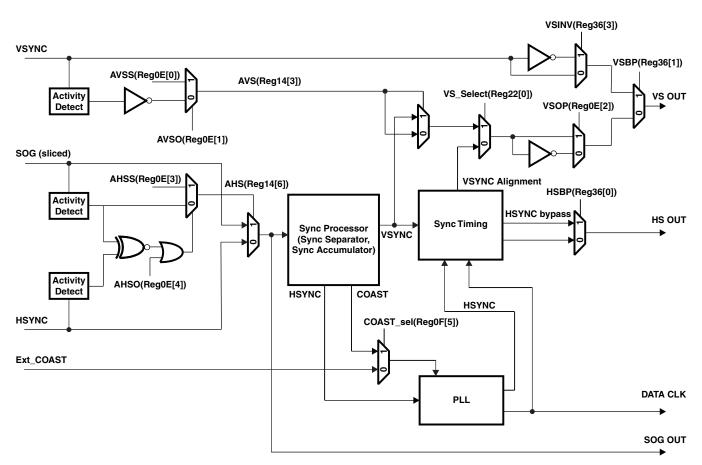


Figure 5. Sync Processing



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### **Output Formatter**

The output formatter sets how the data is formatted for output on the TVP70025I output buses. Table 6 shows the available component video output modes.

Table	e 6. YCbCr Componer	it video Output Form	nats
TERMINAL NAME	TERMINAL NUMBER	30-BIT 4:2:2 YCbCr	20-BIT 4:2:2 YCbCr
G_9	43	Y9	Y9
G_8	44	Y8	Y8
G_7	45	Y7	Y7
G_6	46	Y6	Y6
G_5	47	Y5	Y5
G_4	48	Y4	Y4
G_3	49	Y3	Y3
G_2	50	Y2	Y2
G_1	51	Y1	Y1
G_0	52	YO	Y0
B_9	29	Cb9	Cb9, Cr9
B_8	30	Cb8	Cb8, Cr8
B_7	31	Cb7	Cb7, Cr7
B_6	32	Cb6	Cb6, Cr6
B_5	33	Cb5	Cb5, Cr5
B_4	34	Cb4	Cb4, Cr4
B_3	35	Cb3	Cb3, Cr3
B_2	36	Cb2	Cb2, Cr2
B_1	37	Cb1	Cb1, Cr1
B_0	38	Cb0	Cb0, Cr0
R_9	29	Cr9	
R_8	30	Cr8	
R_7	31	Cr7	
R_6	32	Cr6	
R_5	33	Cr5	
R_4	34	Cr4	
R_3	35	Cr3	
R_2	36	Cr2	
R_1	37	Cr1	
R_0	38	Cr0	

### Table 6. YCbCr Component Video Output Formats<sup>(1)</sup>

(1) 10-bit 4:2:2 YCbCr output format (i.e., ITU-R BT.656) is not supported by the TVP70025I.

#### NOTE

In the 20-bit 4:2:2 YCbCr output mode, the unused Red outputs (Cr[9:0]) are placed in a high-impedance state.



#### Embedded Syncs

Standard embedded syncs insert SAV and EAV codes into the data stream on the rising and falling edges of AVID. These codes contain the V and F bits that also define vertical timing. Table 7 gives the format of the SAV and EAV codes.

H = 1 always indicates EAV. H = 0 always indicates SAV. The alignment of V and F to the line and field counter varies depending on the standard. The P bits are protection bits:

P3 = V xor H P2 = F xor H P1 = F xor V P0 = F xor V xor H

						-				
	Y9 (MSB)	Y8	Y7	Y6	Y5	Y4	Y3	Y2	Y1	Y0
Preamble	1	1	1	1	1	1	1	1	1	1
Preamble	0	0	0	0	0	0	0	0	0	0
Preamble	0	0	0	0	0	0	0	0	0	0
Status	1	F	V	Н	P3	P2	P1	P0	0	0

#### Table 7. EAV and SAV Sequence

The pixel locations where SAV/EAV embedded sync codes are inserted can be programmed using the AVID Start Pixel and AVID Stop Pixel I<sup>2</sup>C registers. The AVID start location is determined from the HSYNC interval, horizontal back porch interval ( $H_{bp}$ ) and a digital process delay factor ( $P_{DELAY}$ ) required for compensation of internal TVP70025I delays. An additional 4 bytes must be added to the active pixel interval between AVID start and AVID stop to accommodate embedded sync insertion.

AVID Start Pixel =  $P_{DELAY}$  + HSYNC +  $H_{bp}$ 

AVID Stop Pixel = AVID Start Pixel + Active Pixels + 4

#### NOTE

Some AVID Stop Pixel calculations will exceed the HPLL-Feedback Register setting, or total pixels per line. When this occurs, subtract total pixels per line from AVID Stop Pixel.

### NOTE

P<sub>DELAY</sub> is typically 27 pixels but may vary slightly depending on other TVP70025I settings such as the Sync-on-Green Threshold setting (I<sup>2</sup>C register 10h) and the SOG LPF setting (I<sup>2</sup>C register 1Ah).

The line numbers where the embedded V-bit and F-bit occur are controlled by I<sup>2</sup>C registers 44h through 49h, which define the vertical blanking interval and field start positions. See Table 8 for typical embedded syncs settings.

Input Format	Output Format	AVID Start Pixel AVID Stop Pixel				VBLK Field 1 Start Line	VBLK Field 0 Durationt	VBLK Field 1 Duration	F-bit Field 0 Start Line	F-bit Field 1 Start Line	
	Register 15h	Register 41h	Register 40h	Register 43h	Register 42h	Register 44h	Register 45h	Register 46h	Register 47h	Register 48h	Register 49h
480i60Hz	47h	00h	95h	00h	0Fh	01h	01h	13h	13h	02h	01h
480p60Hz	47h	00h	93h	00h	0Dh	09h	09h	2Dh	2Dh	00h	00h
720p60Hz	47h	01h	47h	06h	4Bh	05h	05h	1Eh	1Eh	00h	00h
1080i60Hz	47h	01h	07h	08h	8Bh	02h	02h	16h	17h	00h	00h

#### **Table 8. Typical Embedded Sync Settings**



The insertion location of the SAV/EAV codes on a video line is programmable using the AVID start/stop pixel values located at subaddresses 40h through 43h.

### NOTE

When enabled (bit 0 of subaddress 15h), embedded syncs are present in both the Y and C outputs.

### **Output Range Limits**

The TVP70025I provides selectable output range limits in I<sup>2</sup>C subaddress 15h:

- 00 = RGB coding range (Y, Cb, and Cr range from 0 to 1023) (default)
- 01 = Extended coding range (Y, Cb, and Cr range from 4 to 1019)
- 10 = ITU-R BT.601 coding range (Y ranges from 64 to 940, Cb and Cr range from 64 to 960)
- 11 = Reserved

### NOTE

RGB coding range not allowed with embedded syncs.

### Power Management

The TVP70025I supports both automatic and manual power-down modes. The automatic power-down mode can be selected by setting bit 2 of subaddress 0Fh to logic 0.

In the automatic power-down mode, the TVP70025I powers down the ADCs, the ADC reference, and horizontal PLL when activity is not detected on both the selected HSYNC input and the selected SOG input (VSYNC is no longer used). The TVP70025I restores power whenever activity is detected on either the selected HSYNC input or the selected SOG input.

The TVP70025I also can be placed in power-down mode via the active-high PWDN input (pin 70). When the PWDN input is driven high, the TVP70025I powers down everything including the I<sup>2</sup>C interface, and the digital outputs are not placed in a high-impedance mode.

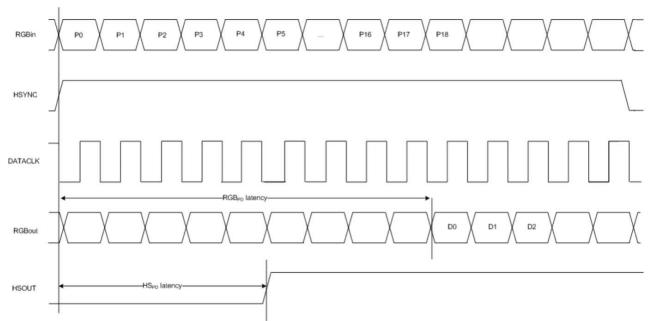
The TVP70025I also can be placed in a power-down mode using bit 1 of register 0Fh.

Individual blocks of the TVP70025I can be independently powered down using register 2Bh.

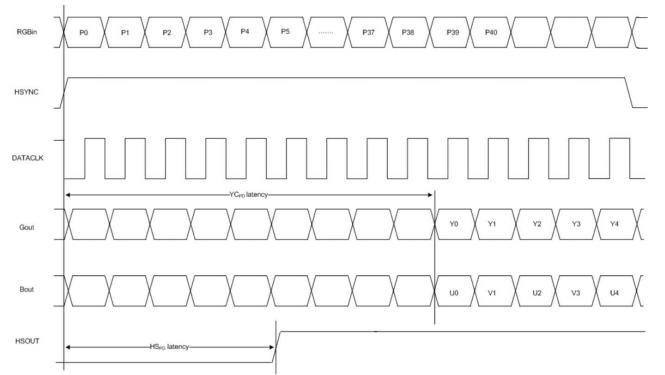


### www.ti.com Timing

The TVP70025I supports RGB/YCbCr 4:4:4 and YCbCr 4:2:2 modes. Output timing is shown in Figure 6. All timing diagrams are shown for operation with internal PLL clock at phase 0 and HSOUT Output Start = 0. For the 4:2:2 mode, CbCr data output is on the BOUT[9:0] output port.



4:4:4 RGB Output Timing. RGB output latency (RGB<sub>PD</sub>) is 18 clock cycles. HSOUT latency (HS<sub>PD</sub>) is 5 clock cycles with HS Start set to 0.



4:2:2 YCbCr Output Timing. YCbCr output latency (YC<sub>PD</sub>) is 39 clock cycles. HSOUT latency (HS<sub>PD</sub>) is 5 clock cycles with HS Start set to 0.

#### Figure 6. Output Timing Diagram



#### I<sup>2</sup>C Host Interface

Communication with the TVP70025I device is via an I<sup>2</sup>C host interface. The I<sup>2</sup>C standard consists of two signals, serial input/output data (SDA) line and input clock line (SCL), which carry information between the devices connected to the bus. A third signal (I2CA) is used for slave address selection. Although an I<sup>2</sup>C system can be multi-mastered, the TVP70025I can function as a slave device only.

Since SDA and SCL are kept open drain at logic high output level or when the bus is not driven, the user should connect SDA and SCL to a positive supply voltage via a pullup resistor on the board. SDA is implemented bidirectional. The slave addresses select, terminal 73 (I2CA), enables the use of two TVP70025I devices tied to the same I<sup>2</sup>C bus, as it controls the least significant bit of the I<sup>2</sup>C device address

SIGNAL	TYPE	DESCRIPTION
I2CA	I	Slave address selection
SCL	I	Input clock line
SDA	I/O	Input/output data line

#### Table 9. I<sup>2</sup>C Host Interface Terminal Description

### **Reset and I<sup>2</sup>C Bus Address Selection**

The TVP70025I can respond to two possible chip addresses. The I<sup>2</sup>C slave address is continuously interpreted from the logic level present at the I2CA terminal. The I<sup>2</sup>C slave address must be configured with an external connection to either IOGND (I<sup>2</sup>C address = B8h) or IOVDD (I<sup>2</sup>C address = BAh). A 2.2-k $\Omega$  pullup or pulldown resistor may be used for this connection.

#### Table 10. I<sup>2</sup>C Host Interface Device Addresses

A6	A5	A4	A3	A2	A1	A0 (I <sup>2</sup> C A)	R/W	HEX
1	0	1	1	1	0	0 <sup>(1)</sup>	1/0	B9h/B8h
1	0	1	1	1	0	1 <sup>(2)</sup>	1/0	BBh/BAh

(1) If I2CA terminal 73 is strapped to IOGND, I<sup>2</sup>C device address A0 is set to 0.

(2) If I2CA terminal 73 is strapped to IOVDD, I<sup>2</sup>C device address A0 is set to 1.

### I<sup>2</sup>C Operation

Data transfers occur utilizing the following illustrated formats.

S 10111000 ACK Subaddress ACK Send data ACK P	Subaddress ACK Send data ACK P	Send data	ACK	Subaddress	ACK	10111000	S
---	--------------------------------	-----------	-----	------------	-----	----------	---

Read from I<sup>2</sup>C control registers

 $S = I^2 C$  bus Start condition

 $P = I^2 C$  bus Stop condition

ACK = Acknowledge generated by the slave

NAK = Acknowledge generated by the master, for multiple byte read master with ACK each byte except last byte

Subaddress = Subaddress byte

Data = Data byte, if more than one byte of DATA is transmitted (read and write), the subaddress pointer is automatically incremented

I<sup>2</sup>C bus address = Example shown that I2CA is in default mode; Write (B8h), Read (B9h).



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### Power Up, Reset, and Initialization

No specific power-up sequence is required, but all power supplies should be active and stable within 500 ms of each other. RESETB may be low during power up, but must remain low for at least 1 µs after the power supplies become stable. Alternatively, reset may be asserted any time with minimum 5-ms delay after power-up and must remain asserted for at least 1 µs. Reset timing is shown in Figure 7. I<sup>2</sup>C SCL and SDA signals must not change state until the TVP70025I reset sequence has been completed. Keeping RESETB low prior to any I<sup>2</sup>C activity prevents this. Table 11 shows the status of the TVP70025I terminals during and immediately after reset.

SIGNAL NAME	O	OUTPUT MODE			
SIGNAL NAME	DURING RESET	RESET COMPLETED			
R[9:0], B[9:0], G[9:0]	High-impedance	Default condition (see bit 0 of subaddress 17h)			
HSOUT, VSOUT, FIDOUT, DATACLK	High-impedance	Default condition (see bit 0 of subaddress 17h)			
SOGOUT	High-↑impedance	Default condition (see bit 1 of subaddress 17h)			

 Table 11. Output Mode Per Reset Sequence State

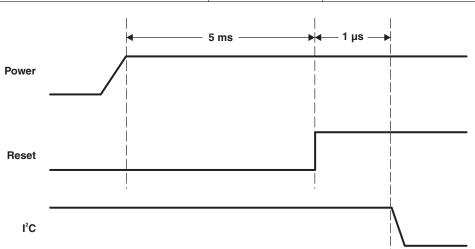


Figure 7. Reset Timing



R/W<sup>(3)</sup>

### CONTROL REGISTERS

The TVP70025I is initialized and controlled by a set of internal registers that define the operating parameters of the entire device. Communication between the external controller and the TVP70025I is through a standard I<sup>2</sup>C host port interface, as previously described.

Table 12 shows the summary of these registers. Detailed programming information for each register is described in the following sections.

Table 12. Control Registers Summary<sup>(1) (2)</sup>

	-	-	
REGISTER NAME	I <sup>2</sup> C SUBADDRESS	DEFAULT	
	00h	02h	
Divider MSBs	01h	67h	
Divider LSBs	02h	20h	
	03h	A8h	
lect	04h	80h	
	051	0.01	

	100000000000000000000000000000000000000	DEIMOLI	
Chip Revision	00h	02h	R
H-PLL Feedback Divider MSBs	01h	67h	R/W
H-PLL Feedback Divider LSBs	02h	20h	R/W
H-PLL Control	03h	A8h	R/W
H-PLL Phase Select	04h	80h	R/W
Clamp Start	05h	32h	R/W
Clamp Width	06h	20h	R/W
HSYNC Output Width	07h	20h	R/W
Blue Fine Gain	08h	00h	R/W
Green Fine Gain	09h	00h	R/W
Red Fine Gain	0Ah	00h	R/W
Blue Fine Offset MSBs	0Bh	80h	R/W
Green Fine Offset MSBs	0Ch	80h	R/W
Red Fine Offset MSBs	0Dh	80h	R/W
Sync Control 1	0Eh	5Bh	R/W
H-PLL and Clamp Control	0Fh	2Eh	R/W
Sync On Green Threshold	10h	5Dh	R/W
Sync Separator Threshold	11h	20h	R/W
H-PLL Pre-Coast	12h	00h	R/W
H-PLL Post-Coast	13h	00h	R/W
Sync Detect Status	14h		R
Output Formatter	15h	04h	R/W
MISC Control 1	16h	11h	R/W
MISC Control 2	17h	03h	R/W
MISC Control 3	18h	00h	R/W
Input Mux Select 1	19h	00h	R/W
Input Mux Select 2	1Ah	C2h	R/W
Blue and Green Coarse Gain	1Bh	77h	R/W
Red Coarse Gain	1Ch	07h	R/W
Fine Offset LSBs	1Dh	00h	R/W
Blue Coarse Offset	1Eh	10h	R/W
Green Coarse Offset	1Fh	10h	R/W
Red Coarse Offset	20h	10h	R/W
HSOUT Output Start	21h	0Dh	R/W
MISC Control 4	22h	08h	R/W
Blue Digital ALC Output LSBs	23h		R
Green Digital ALC Output LSBs	24h		R

(1) For proper operation of the TVP70025I device, the default settings for all register locations designated as "Reserved" in the register map summary should never be changed from the values provided.

For registers with reserved bits, a 0b must be written to reserved bit locations, unless otherwise stated. (2)

R = Read only, W = Write only, R/W = Read/Write (3)

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## TVP70025I

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Table 12. Control Registers Summary <sup>(1) (2)</sup> (continued	I)
---	----

REGISTER NAME	I <sup>2</sup> C SUBADDRESS	DEFAULT	R/W <sup>(3)</sup>
Red Digital ALC Output LSBs	25h		R
Automatic Level Control Enable	26h	80h	R/W
Digital ALC Output MSBs	27h		R
Automatic Level Control Filter	28h	53h	R/W
Reserved	29h	08h	R/W
Fine Clamp Control	2Ah	07h	R/W
Power Control	2Bh	00h	R/W
ADC Setup	2Ch	50h	R/W
Coarse Clamp Control	2Dh	00h	R/W
SOG Clamp	2Eh	80h	R/W
RGB Coarse Clamp Control	2Fh	8Ch	R/W
SOG Coarse Clamp Control	30h	04h	R/W
ALC Placement	31h	5Ah	R/W
Reserved	32h	18h	R/W
Reserved	33h	60h	R/W
Macrovision Stripper Width	34h	03h	R/W
VSYNC Alignment	35h	10h	R/W
Sync Bypass	36h	00h	R/W
Lines Per Frame Status	37h–38h		R
Clocks Per Line Status	39h–3Ah		R
HSYNC Width	3Bh		R
VSYNC Width	3Ch		R
Line Length Tolerance	3Dh	03h	R/W
Reserved	3Eh	04h	R/W
Video Bandwidth Control	3Fh	00h	R/W
AVID Start Pixel	40h–41h	012Ch	R/W
AVID Stop Pixel	42h–43h	062Ch	R/W
VBLK Field 0 Start Line Offset	44h	05h	R/W
VBLK Field 1 Start Line Offset	45h	05h	R/W
VBLK Field 0 Duration	46h	1Eh	R/W
VBLK Field 1 Duration	47h	1Eh	R/W
F-bit Field 0 Start Line Offset	48h	00h	R/W
F-bit Field 1 Start Line Offset	49h	00h	R/W
1st CSC Coefficient	4Ah–4Bh	16E3h	R/W
2nd CSC Coefficient	4Ch–4Dh	024Fh	R/W
3rd CSC Coefficient	4Eh–4Fh	06CEh	R/W
4th CSC Coefficient	50h–51h	F3ABh	R/W
5th CSC Coefficient	52h–53h	1000h	R/W
6th CSC Coefficient	54h–55h	FC55h	R/W
7th CSC Coefficient	56h–57h	F178h	R/W
8th CSC Coefficient	58h–59h	FE88h	R/W
9th CSC Coefficient	5Ah–5Bh	1000h	R/W
Reserved	5Ch–5Dh	0000h	R/W
Reserved	5Eh–FFh	0000h	R/W

### **Register Definitions**

### **Chip Revision**

Subaddress	00h						Read Only		
7	6	5	4	3	2	1	0		
	Chip revision [7:0]								

Chip revision [7:0]: Chip revision number. The chip revision number is 02h for the TVP70025I.

#### NOTE

The TVP70025I has a chip revision number that is unique from the TVP7000 and TVP7001 devices.

#### H-PLL Feedback Divider MSBs

Subaddress	01h						Default (67h)			
7	6	5	4	3	2	1	0			
	PLL divide [11:4]									

PLL divide [11:0]: Controls the 12-bit horizontal PLL feedback divider value that determines the number of pixels per line. PLL divide [11:4] bits should be loaded first whenever a change is required.

### H-PLL Feedback Divider LSBs

Subaddress	02h						Default (20h)
7	6	5	4	3	2	1	0
	PLL div	ride [3:0]		Reserved			

PLL divide [11:0]: Controls the 12-bit horizontal PLL feedback divider value that determines the number of pixels per line. PLL divide [11:4] bits should be loaded first whenever a change is required.

### **H-PLL Control**

Subaddress	03h						Default (A8h)
7	6	5	4	3	2	1	0
VCC	0 [1:0]	Char	Charge Pump Current [2:0]		Reserved		

VCO [1:0]: Selects VCO gain ( $K_{VCO}$ ) and corresponding output frequency range.

	VCO Gain (K <sub>VCO</sub> )	VCO Range	Pixel Clock Frequency (PCLK)
00 =	75	Ultra low	PCLK < 36 MHz
01 =	85	Low	36 MHz ≤ PCLK < 70 MHz
10 =	150	Medium (default)	70 MHz ≤ PCLK ≤ 90 MHz
11 =	Reserved	Reserved	Reserved
· · · · · ·		and DLL shares around a second start	<b></b>

Charge Pump Current [2:0]: Selects PLL charge pump current setting. The recommended charge pump current setting ( $I_{CP}$ ) can be determined using the following equation.

 $I_{CP} = 40 \times K_{VCO}/(pixels per line)$ 

000 = 0: Small

101 = 5 (default)

111 = 7: Large

NOTE: Also see the PLL and CLAMP Control register at subaddress 0Fh.



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#### **H-PLL Phase Select**

Subaddress	04h						Default (80h)
7	6	5	4	3	2	1	0
		Phase Select [4:0	1		Rese	erved	DIV2

Phase Select [4:0]: ADC sampling clock phase select. (1 LSB = 360/32 = 11.25°). A host-based automatic phase control algorithm can be used to control this setting to optimize graphics sampling phase.

00h = 0 degrees

10h = 180 degrees (default)

1Fh = 348.75 degrees

DIV2: DATACLK divide-by-2. H-PLL post divider. May be used with 2x H-PLL Feedback Divider to improve jitter performance, when lower frequency SDTV formats are used.

0 = DATACLK/1 (default)

1 = DATACLK/2

#### **Clamp Start**

Subaddress	05h						Default (32h)			
7	6	5	4	3	2	1	0			
	Clamp Start [7:0]									

Clamp Start [7:0]: Positions the clamp signal an integer number of clock periods after the HSYNC signal. If external clamping is selected this value has no meaning. See Table 13 for the recommended settings.

### **Clamp Width**

Subaddress	06h						Default (20h)
7	6	5	4	3	2	1	0
Clamp Width [7:0]							

Clamp Width [7:0]: Sets the width in pixels for the fine clamp. See also register Clamp Start (subaddress 05h).

#### **Table 13. Recommended Fine Clamp Settings**

VIDEO STANDARD	CLAMP START	CLAMP WIDTH
HDTV (tri-level)	50 (32h)	32 (20h)
SDTV (bi-level)	6 (06h)	16 (10h)
PC graphics	6 (06h)	16 (10h)

#### **HSYNC Output Width**

Subaddress	07h						Default (20h)
7	6	5	4	3	2	1	0
HSOUT Width [7:0]							

HSOUT Width [7:0]: Sets the width in pixels for HSYNC output.

#### **Blue Fine Gain**

Subaddress	08h						Default (00h)
7	6	5	4	3	2	1	0
Blue Fine Gain [7:0]							

Blue Fine Gain [7:0]: 8-bit fine digital gain (contrast) for Blue channel (applied after the ADC). Offset binary value. Blue Fine Gain = 1 + Blue Fine Gain  $[7 \cdot 0]/256$ 

siue Fine Gain = 1 + Blue Fine Gain [	/:0]/256
Blue Fine Gain [7:0]	Blue Fin

Blue Fine Gain [7:0]	Blue Fine Gain
00h	1.0 (default)
80h	1.5
FFh	2.0

### **Green Fine Gain**

Subaddress	09h						Default (00h)
7	6	5	4	3	2	1	0
Green Fine Gain [7:0]							

Green Fine Gain [7:0]: 8-bit fine digital gain (contrast) for Green channel (applied after the ADC). Offset binary value. Green Fine Gain = 1 + Green Fine Gain [7:0]/256

Green Fine Gain [7:0]	Green Fine Gain
00h	1.0 (default)
80h	1.5
FFh	2.0

### **Red Fine Gain**

Subaddress	0Ah						Default (00h)	
7	6	5	4	3	2	1	0	
Red Fine Gain [7:0]								

Red Fine Gain [7:0]: 8-bit fine digital gain (contrast) for Red channel (applied after the ADC). Offset binary value. Red Fine Gain = 1 + Red Fine Gain [7:0]/256

Red Fine Gain [7:0]	Red Fine Gain
00h	1.0 (default)
80h	1.5
FFh	2.0

### **Blue Fine Offset MSBs**

Subaddress	0Bh						Default (80h)	
7	6	5	4	3	2	1	0	
Blue Fine Offset [9:2]								

Blue Fine Offset [9:2]: Eight MSBs of 10-bit fine digital offset (brightness) for Blue channel (applied after ADC). Corresponding two LSBs located at register 1Dh. Offset binary value.

The default setting of 80h places the bottom-level (RGB) clamped output blank levels at 0 and mid-level clamped (PbPr) output blank levels at 512.

FFh = Maximum blue fine offset MSBs

81h = 1 count (out of 256)

80h = 0 (default)

7Fh = -1 count (out of 256)

00h = Minimum blue fine offset MSBs

#### **Green Fine Offset MSBs**

Subaddress	0Ch						Default (80h)			
7	6	5	4	3	2	1	0			
	Green Fine Offset [9:2]									

Green Fine Offset [9:2]: Eight MSBs of 10-bit fine digital offset (brightness) for Green channel (applied after ADC). Corresponding two LSBs located at register 1Dh. Offset binary value.

The default setting of 80h places the bottom-level (RGB) clamped output blank levels at 0 and mid-level clamped (PbPr) output blank levels at 512.

FFh = Maximum green fine offset MSBs

81h = 1 count (out of 256)

80h = 0 (default)

7Fh = -1 count (out of 256)

00h = Minimum green fine offset MSBs

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#### Red Fine Offset MSBs

Subaddress	0Dh						Default (80h)			
7	6	5	4	3	2	1	0			
	Red Fine Offset [9:2]									

Red Fine Offset [9:2]: 8 MSBs of 10-bit fine digital offset (brightness) for Red channel (applied after ADC). Corresponding two LSBs located at register 1Dh. Offset binary value.

The default setting of 80h places the bottom-level (RGB) clamped output blank levels at 0 and mid-level clamped (PbPr) output blank levels at 512.

FFh = Maximum red fine offset MSBs

81h = 1 count (out of 256)

80h = 0 (default)

7Fh = -1 count (out of 256)

00h = Minimum red fine offset MSBs

### Sync Control 1

Subaddress	0Eh						Default (5Bh)
7	6	5	4	3	2	1	0
HSPO	HSIP	HSOP	AHSO	AHSS	VSOP	AVSO	AVSS

HSPO: HSYNC polarity override

- 0 = Polarity determined by chip (default)
- 1 = Polarity set by bit 6 in register 0Eh (not recommended)
- HSIP: HSYNC input polarity
  - 0 = Indicates input HSYNC polarity active low
  - 1 = Indicates input HSYNC polarity active high (default)
- HSOP: HSYNC output polarity
  - 0 = Active-low HSYNC output (default)
  - 1 = Active-high HSYNC output
    - NOTE: HSOP has no effect in raw sync bypass mode. See register 36h.
- AHSO: Active HSYNC override
  - 0 = Active HSYNC is automatically selected by TVP70025I. If selected, SOG and HSYNC inputs both have active inputs, HSYNC is selected as the active sync source. The selected active HSYNC is provided via the AHS status bit (bit 6 of register 14h).
  - 1 = Active HSYNC is manually selected via the AHSS control bit (bit 3 of register 0Eh). (default)

AHSS: Active HSYNC select. The indicated HSYNC is used only if the AHSO control bit (bit 4) is set to 1 or if activity is detected on both the selected HSYNC input and the selected SOG input (bits 1, 7 = 1 in register 14h).

- 0 = Active HSYNC is derived from the selected HSYNC input.
- 1 = Active HSYNC is derived from the selected SOG input (default).
- VSOP: VSYNC output polarity
  - 0 = Active-low VSYNC output (default)
  - 1 = Active-high VSYNC output
- AVSO: Active VSYNC override
  - 0 = Active VSYNC is automatically selected by TVP70025I. If selected, SOG and VSYNC inputs both have active inputs, VSYNC is selected as the active sync source. The selected active VSYNC is provided via the AVS status bit (bit 3 of register 14h).
  - 1 = Active VSYNC is manually selected via the AVSS control bit (bit 0 of register 0Eh) (default).
  - NOTE: Automatic sync selection should be enabled only for 5-wire PC graphics inputs.
- AVSS: Active VSYNC select. This bit is effective when the AVSO control bit (bit 1) is set to 1.
  - 0 = Active VSYNC is derived from the selected VSYNC input.
  - 1 = Active VSYNC is derived from the Sync separated VSYNC (default).

# H-PLL and Clamp Control

#### Subaddress 0Fh

Subaddress	0Fh	DFh Defa								
7	6	5	4	3	2	1	0			
CF	CP	Coast Sel	CPO	CPC	SMO	FCPD	ADC Test			

CF: Clamp Function. Clamp pulse select. This control bit determines whether the timing for both the fine clamp and the ALC circuit are generated internally or externally.

0 = Internal fine clamp and ALC timing (default)

1 = External fine clamp and ALC timing (pin 76)

CP: Clamp Polarity. External clamp polarity select

- 0 = Active-high clamp pulse (default)
- 1 = Active-low clamp pulse

CS: Coast Select. Coast signal select. This control bit determines whether the timing for H-PLL coast signal is generated internally or externally.

- 0 = External H-PLL coast timing (pin 77)
- 1 = Internal H-PLL coast timing (default)
- CPO: Coast Polarity Override
  - 0 = Polarity determined by chip (default)
  - 1 = Polarity set be Bit 3 in register 0Fh
- CPC: Coast Polarity Change. External coast polarity select
  - 0 = Active-low coast signal
  - 1 = Active-high coast signal (default)
- SMO: Seek Mode Override. Places the TVP70025I in a low power mode whenever no activity is detected on the selected sync inputs.
  - 0 = Enable automatic power management mode
  - 1 = Disable automatic power management mode (default)
    - NOTE: Digital outputs are not high impedance and may be in a random state during low power mode. Outputs can be put in high impedance state by I<sup>2</sup>C register 17h.
- FCPD: Full Chip Power Down. Active-low power down. FCPD powers down all blocks except I<sup>2</sup>C. The I<sup>2</sup>C register values are retained.
  - 0 = Power-down mode
  - 1 = Normal operation (default)
    - NOTE: Digital outputs are not high impedance and may be in random state during FCPD. Outputs can be put in high impedance state by I<sup>2</sup>C register 17h.

ADC Test: Active-high ADC test mode select. When placed in the ADC test mode, the TVP70025I disables the fine clamp, enables the coarse clamp, and selects the external clock input (pin 80) for each ADC channel.

- 0 = ADC test mode disabled (default)
  - 1 = ADC test mode enabled

NOTE: Also see the Horizontal PLL Control register at subaddress 03h.

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#### Sync-On-Green Threshold

Subaddress	10h						Default (5Dh)
7	6	5	4	3	2	1	0
	S	OG Threshold [4:	0]		Blue CS	Green CS	Red CS

SOG Threshold [4:0]: Sets the voltage level of the SOG slicer comparator according to the following equation.

slice\_level =  $(350 \text{ mV}) \times (N_{TH}/31)$ 

00h = 0 mV

0Bh = 124 mV (default)

1Fh = 350 mV

Blue Clamp Select: This bit has no effect when the Blue channel fine clamp is disabled (bit 2 of subaddress 2Ah).

0 = Bottom-level fine clamp

1 = Mid-level fine clamp (default)

Green Clamp Select: This bit has no effect when the Green channel fine clamp is disabled (bit 1 of subaddress 2Ah).

0 = Bottom-level fine clamp (default)

1 = Mid level fine clamp

Red Clamp Select: This bit has no effect when the Red channel fine clamp is disabled (bit 0 of subaddress 2Ah).

0 = Bottom-level fine clamp

1 = Mid-level fine clamp (default)

NOTE: Bottom-level clamping is required for Y and RGB inputs, while mid-level clamping is required for Pb and Pr inputs. The internal clamp pulse also must be correctly positioned for proper clamp operation (see register 05h)

#### Sync Separator Threshold

Subaddress	11h						Default (20h)		
7	6	5	4	3	2	1	0		
	Sync Separator Threshold [7:0]								

Sync Separator Threshold [7:0]: Sets how many internal clock reference periods the sync separator counts to before toggling high or low. Sync Separator Threshold [7:0]  $\times$  (minimum clock period) must be greater than the width of the negative sync pulse. This setting also can affect the position of the VSOUT (see register 22h).

NOTE: The internal clock reference is typically 6.5 MHz, but a minimum clock period of 133 ns is recommended to allow for clock variation. 40h = recommended setting for support of most video formats

NOTE: Margin for a particular format can be maximized by using a mid-range setting as shown in Table 14.

	<i>,</i>					
Format	MIN	MID	МАХ			
480i60Hz	1Fh	75h	ABh			
480p60Hz	10h	64h	BAh			
576i50Hz	20h	75h	ACh			
576p50Hz	11h	64h	BCh			
720p60Hz	1Bh	43h	6Ch			
720p50Hz	37h	50h	6Ch			
1080i60Hz	0Eh	2Ch	4Bh			
1080i50Hz	21h	36h	4Bh			

#### **Table 14. Sync Separator Threshold Ranges**

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### **H-PLL Pre-Coast**

Subaddress	12h						Default (00h)			
7	6	5	4	3	2	1	0			
	Pre-Coast [7:0]									

Pre-Coast [7:0]: Sets the number of HSYNC periods that coast becomes active prior to VSYNC leading edge. A minimum setting of 1 is required to ensure generation of an internal coast signal.

00h = Minimum setting (default)

01h = 1 HSYNC period (recommendation)

FFh = Maximum setting

### **H-PLL Post-Coast**

Subaddress	13h						Default (00h)			
7	6	5	4	3	2	1	0			
	Post-Coast [7:0]									

Post-Coast [7:0]: Sets the number of HSYNC periods that coast stays active following VSYNC trailing edge.

### Table 15. Recommended H-PLL Pre-Coast and H-PLL Post-Coast Settings

STANDARD	H-PLL PRE_COAST	H-PLL POST-COAST
480i/p with Macrovision	3	03h
576i/p with Macrovision	3	03h
720p	1	0
1080i	1	0
PC Graphics with SOG	1	0



### Sync Detect Status

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Subaddress	14h			T	1	<u>_</u>	Read
7	6	5	4	3	2	1	0
HSD	AHS	IHSPD	VSD	AVS	VSPD	SOGD	ICPD
HSD: HSYNC E	Detect. HSYNC activ	vity detection for s	elected HSYNC	input (pin 81 or 82	2).		
0 =	No HSYNC activi	ity detected					
1 =	<ul> <li>HSYNC activity c</li> </ul>	letected					
AHS: Active HS	YNC. Indicates who	ether the active H	SYNC is derived	from the selected	HSYNC input or th	ne selected SOG i	nput.
0 =	<ul> <li>HSYNC from sele</li> </ul>	ected HSYNC inp	ut (pin 81 or 82)				
1 =	<ul> <li>HSYNC from sele</li> </ul>	ected SOG input (	pin 1, 99, or 97)				
IHSPD: Input H	SYNC Polarity Dete	ect. HSYNC polari	ty detection for s	elected HSYNC in	put (pin 81 or 82).		
0 =	Active-low HSYN	С					
1 =	Active-high HSY	NC					
VSD: VSYNC D	etect. VSYNC activ	vity detection for s	elected VSYNC i	nput (pin 78 or 79	).		
0 =	<ul> <li>No VSYNC activi</li> </ul>	ty detected					
1 =	<ul> <li>VSYNC activity d</li> </ul>	letected					
AVS: Active VS	YNC. Indicates whe	ether the active VS	SYNC is derived	from the selected	VSYNC input or th	e sync separator.	
0 =	<ul> <li>VSYNC from sele</li> </ul>	ected VSYNC inpu	ut (pin 78 or 79)				
1 =	<ul> <li>VSYNC from syn</li> </ul>	c separator					
VSPD: Input VS	SYNC Polarity Dete	ct. VSYNC polarity	y detection for se	elected VSYNC inp	ut (pin 78 or 79).		
0 =	<ul> <li>Active-low VSYN</li> </ul>	С					
1 =	<ul> <li>Active-high VSYN</li> </ul>	NC					
SOGD: SOG D	etect. SOG activity	detection for selec	cted SOG input (	pin 1, 99, or 97).			
0 =	<ul> <li>No SOG activity</li> </ul>	detected					
1 =	<ul> <li>SOG activity determined</li> </ul>	ected					
ICPD: Input Co	ast Polarity Detect.	Coast signal pola	rity detection.				
0 =	Active-low coast	signal					
1 =	<ul> <li>Active-high coast</li> </ul>	signal					

#### NOTE

See the Sync Control register at subaddress 0Eh.

### **Output Formatter**

Subaddress	15h						Default (04h)
7	6	5	4	3	2	1	0
Reserved	Output code range [1:0]		Reserved	Clamp REF	CbCr order	422/444	Sync En

Reserved [7]:

0 = Required (default)

Output code range [1:0]:

00 = RGB coding range (Y, Cb, and Cr range from 0 to 1023) (default)

- 01 = Extended coding range (Y, Cb, and Cr range from 4 to 1019)
- 10 = ITU-R BT.601 coding range (Y ranges from 64 to 940, Cb and Cr range from 64 to 960)
- 11 = Reserved
- Reserved [4]:

0 = Required (default)

Clamp REF: Selects which edge of HSYNC is used as the timing reference for the fine clamp pulse placement and also the ALC placement.

- 0 = Clamp pulse placement referred to the trailing edge of HSYNC (default)
- 1 = Clamp pulse placement referred to the leading edge of HSYNC
- CbCr order: This bit is only effective in the 4:2:2 output mode (i.e., bit 1 is set to 1).
  - 0 = CbCr order
  - 1 = CrCb order (default)

422/444: Active-high 4:4:4 to 4:2:2 decimation filter enable

- 0 = 30-bit 4:4:4 output format (default)
- 1 = 20-bit 4:2:2 output format

Notes:

1. Multiplexed CbCr data is output on BOUT [9:0] in the 20-bit 4:2:2 output format.

2. 10-bit 4:2:2 output format is not supported.

Sync En: Active-high embedded sync enable

- 0 = Embedded sync disabled (default)
- 1 = Embedded sync enabled

Notes:

- 1. Embedded syncs are not supported when the RGB coding range (0 to 1023) is selected.
- 2. Embedded syncs are not supported when the 30-bit 4:4:4 output format is selected.
- 3. Discrete syncs are always enabled except when outputs are placed in the high-impedance mode.
- 4. When enabled, embedded syncs are present in both the Y and C outputs.

### **MISC Control 1**

Subaddress	16h						Default (11h)
7	6	5	4	3	2	1	0
Reserved			CbCr Align	Reserved		PLL PD	STRTB

CbCr Align: CbCr alignment

0 = Alternative operation

1 = Normal operation (default)

PLL PD: Active-high H-PLL power down

0 = Normal operation (default)

1 = H-PLL powered down

STRTB: Active-high H-PLL start-up circuit enable

- 0 = H-PLL start-up circuit disabled
- 1 = H-PLL start-up circuit enabled (default)

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# **MISC Control 2**

Subaddress	17h						Default (03h)
7	6	5	4	3	2	1	0
Reserved	Test output control [2:0]			Rese	erved	SOG En	Output En

Test output control [2:0]: Selects which signal is output on pin 22. Output polarity control is also provided using bit 2 of subaddress 18h.

- 000 = Field ID output (default)
- 001 = Data Enable output
- 010 = Reserved
- 011 = Reserved
- 100 = Internal clock reference output (~6.5 MHz typical)
- 101 = Coast output
- 110 = Clamp pulse output
- 111 = High-impedance mode

SOG En: Active-low output enable for SOGOUT output.

- 0 = SOG output enabled
- 1 = SOG output placed in high-impedance mode (default)

Output En: Active-low output enable for RGB, DATACLK, HSOUT, VSOUT, and FIDOUT outputs. This control bit allows selecting a high-impedance output mode for multiplexing the output of the TVP70025I with another device.

- 0 = Outputs enabled
- 1 = Outputs placed in high-impedance mode (default)
  - NOTE: Data Enable output is equivalent to the internal active video signal that is controlled by the AVID start/stop pixel values and the VBLK offset/duration line values.

# **MISC Control 3**

Subaddress	18h						Default (00h)
7	6	5	4	3	2	1	0
Reserved	Reserved	Blank En	CSC En	Reserved	FID POL	SOG POL	CLK POL

Reserved [7]:

0 = Required (default)

Blank En: Active-high blank level enable. Forces the video blank level to a standard value when using embedded syncs.

- 0 = Normal operation (default)
- 1 = Force standard blank levels

CSC En: Active-high CSC enable. When disabled, the CSC block is bypassed.

- 0 = CSC disabled (default)
- 1 = CSC enabled

FID POL: Active-high Field ID output polarity control. Under normal operation, the field ID output is set to logic 1 for an odd field (field 1) and set to logic 0 for an even field (field 0).

- 0 = Normal operation (default)
- 1 = FID output polarity inverted

NOTE: This control bit also affects the polarity of the data enable output when selected (see Test output control [2:0] at subaddress 17h).

- SOG POL: Active-high SOG output polarity control
  - 0 = Normal operation (default)
  - 1 = SOG output polarity inverted
- CLK POL: Allows selecting the polarity of the output data clock.
  - 0 = Data is clocked out on rising edge of DATACLK (default)
  - 1 = Data is clocked out on falling edge of DATACLK

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# Input Mux Select 1

Subaddress	19h						Default (00h)
7	6	5	4	3	2	1	0
SOG Select [1:0]		Red Select [1:0]		Green Select [1:0]		Blue Select [1:0]	
SOG Select [1:0	0]: Selects one of th	ree SOG inputs.					
00 =	<ul> <li>SOGIN_1 input set</li> </ul>	elected (default)					

- 01 = SOGIN\_2 input selected
- 10 = SOGIN\_3 input selected
- 11 = Reserved

Red Select [1:0]: Selects one of three R/Pr inputs.

- 00 = RIN\_1 input selected (default)
  - 01 = RIN\_2 input selected
  - 10 = RIN\_3 input selected
- 11 = Reserved

Green Select [1:0]: Selects one of four G/Y inputs.

00 = GIN\_1 input selected (default)

- 01 = GIN\_2 input selected
- 10 = GIN\_3 input selected
- 11 = GIN\_4 input selected

Blue Select [1:0]: Selects one of three B/Pb inputs.

- 00 = BIN\_1 input selected (default)
- 01 = BIN\_2 input selected
- 10 = BIN\_3 input selected

11 = Reserved

EXAS

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Default (C2h)

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#### Input Mux Select 2

#### Subaddress 1Ah

00000000000							Default (OZII)
7	6	5	4	3	2	1	0
SOG LPF SEL [1:0]		CLP LPF	SEL [1:0]	CLK SEL	VS SEL	PCLK SEL	HS SEL

SOG LPF SEL [1:0]: SOG low-pass filter selection. The SOG low-pass filter can be used to attenuate glitches present on the SOG input. Excessive filtering can lead to sync detection issues and increased sample clock jitter.

00 = 2.5-MHz low-pass filter

01 = 10-MHz low-pass filter

10 = 33-MHz low-pass filter

11 = Low-pass filter bypass (default)

NOTE: The SOG LPF setting can affect HSYNC delay in the TVP70025I. Additionally, excessive filtering of HDTV and graphics SOG sources can lead to sync attenuation and sync extraction issues.

CLP LPF SEL [1:0]: Coarse clamp low-pass filter selection. This filter affects the operation of all enabled coarse clamps which is generally the SOG coarse clamp only.

- 00 = 4.8-MHz low-pass filter (default). Suitable for HDTV and graphics formats.
- 01 = 0.5-MHz low-pass filter. Suitable for SDTV formats.
- 10 = 1.7-MHz low-pass filter
- 11 = Reserved

CLK SEL: Clock reference select for Sync Processing block. The internal reference clock is typically 6.5 MHz, but it should not be considered a precise clock. An external 27-MHz reference clock is therefore recommended for accurate mode detection. NOTE: The I<sup>2</sup>C interface, Sync Separator, and activity detection circuitry always uses the internal clock reference.

- 0 = Internal clock reference (default)
- 1 = External clock reference (EXT\_CLK)
  - NOTE: The external clock input also can be selected as the sample clock for the ADCs (see bit 1).

#### VS SEL: VSYNC input select

- 0 = VSYNC\_A input selected (default)
- 1 = VSYNC\_B input selected

PCLK SEL: Pixel clock selection. When the external clock input (pin 80) is selected as the ADC sample clock, the external clamp pulse (pin 76) also should be selected (Bit 7 of subaddress 0Fh).

- 0 = ADC samples data using external clock input (pin 80)
- 1 = ADC samples data using H-PLL generated clock (default)

NOTE: The external clock input also can be selected as the reference clock for the Sync Processing block (see bit 3).

- HS SEL: HSYNC input select
  - 0 = HSYNC\_A input selected (default)
  - 1 = HSYNC\_B input selected

NOTE: See the Sync Control register at subaddress 0Eh.

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#### Blue and Green Coarse Gain

Subaddress	1Bh						Default (77h)	
7	6	5	4	3	2	1	0	
	Green Coar	se Gain [3:0]		Blue Coarse Gain [3:0]				

Green Coarse Gain [3:0]: 4-bit coarse analog gain for Green channel (applied before the ADC). To avoid clipping at the ADC,  $V_{PP}$  in X Gain must be less than 1  $V_{PP}$ .

Gain [3:0]	Description
0000 = 0.5	
0001 = 0.6	
0010 = 0.7	
0011 = 0.8	
0100 = 0.9	
0101 = 1.0	
0110 = 1.1	
0111 = 1.2	Default
1000 = 1.3	Maximum recommended gain for 700 $\mathrm{mV}_{\mathrm{PP}}$ input
1001 = 1.4	
1010 = 1.5	
1011 = 1.6	
1100 = 1.7	
1101 = 1.8	
1110 = 1.8	
1111 = 2.0	

Blue Coarse Gain [3:0]: 4-bit coarse analog gain for Blue channel (applied before the ADC).

## **Red Coarse Gain**

Subaddress	1Ch						Default (07h)	
7	6	5	4	3	2	1	0	
	Rese	erved		Red Coarse Gain [3:0]				

Red Coarse Gain [3:0]: 4-bit coarse analog gain for Red channel (applied before ADC).

#### Fine Offset LSBs

Subaddress	1Dh						Default (00h)	
7	6	5	4	3	2	1	0	
Reserved		Red Fine Offset [1:0]		Green Fine	Offset [1:0]	Blue Fine Offset [1:0]		

Red Fine Offset [1:0]: Two LSBs of 10-bit fine digital offset for Red channel (applied after ADC). Corresponding eight MSBs located at register 0Dh. Offset binary value

Green Fine Offset [1:0]: Two LSBs of 10-bit fine digital offset for Green channel (applied after ADC). Corresponding eight MSBs located at register 0Ch. Offset binary value.

Blue Fine Offset [1:0]: Two LSBs of 10-bit fine digital offset for Blue channel (applied after ADC). Corresponding eight MSBs located at register 0Bh. Offset binary value.



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# **Blue Coarse Offset**

Subaddress	1Eh						Default (10h)	
7	6	5	4	3	2	1	0	
Res	erved	Blue Coarse Offset [5:0]						

Blue Coarse Offset [5:0]: 6-bit coarse analog offset for Blue channel (applied before ADC). 6-bit sign magnitude value. Coarse Offset settings less than 10h can lead to bottom level clipping at the ADC input.

1Fh = +124 counts

10h = +64 counts referred to ADC output (default)

- 01h = +4 counts
- 00h = +0 counts 20h = -0 counts
- 21h = -4 counts
- 3Fh = -124 LSB

# **Green Coarse Offset**

Subaddress	1Fh						Default (10h)	
7	6	5	4	3	2	1	0	
Reserved		Green Coarse Offset [5:0]						

Green Coarse Offset [5:0]: 6-bit coarse analog offset for Green channel (applied before ADC). 6-bit sign magnitude value.

#### **Red Coarse Offset**

Subaddress	20h						Default (10h)	
7	6	5	4	3	2	1	0	
Reserved		Red Coarse Offset [5:0]						

Red Coarse Offset [5:0]: 6-bit coarse analog offset for Red channel (applied before ADC). 6-bit sign magnitude value.

#### **HSOUT Output Start**

Subaddress	21h						Default (0Dh)		
7	6	5	4	3	2	1	0		
HSOUT Start [7:0]									

HSOUT Start [7:0]: Adjusts the leading edge of the HSYNC output relative to the leading edge of the HSYNC input in pixel or clock cycles.

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# **MISC Control 4**

SP Reset

Subaddress	22h					
7	6	5	4	3	2	1

SP Reset: Active-high reset for Sync Processing block. This bit may be used to manually reset the sync separator, sync accumulator, activity and polarity detectors, and line and pixels counters.

0 = Normal operation (default)

1 = Sync processing reset

Yadj\_delay [2:0]: Adjusts the phase delay of the luma output relative to the chroma output. Used to compensate for the chroma delay associated with the 4:4:4 to 4:2:2 chroma sample conversion.

0h = Minimum delay (default)

7h = Maximum delay

MAC\_EN: Toggling of the MAC\_EN bit was required for TVP7000 and TVP7001 Macrovision support. This is no longer required with the TVP700251.

- 0 = Macrovision stripper disabled.
- 1 = Macrovision stripper enabled (default)
  - NOTE: When the Macrovsion stripper is enabled, sync separation and ALC and Clamp pulse placement is affected by the Macrovision Stripper Width setting. See Register 34h for details.

MAC\_EN

Coast Dis

VS Select

Coast Dis: Active-high internal coast signal disable for 5-wire PC graphics inputs. Has no effect when the external coast signal is selected. See bit 5 of register 0Fh.

- 0 = Internal coast signal enabled (default)
- 1 = Internal coast signal disabled

#### VS Select: VSYNC select

- 0 = VSOUT is generated by the sync separator.
- 1 = VSOUT is generated by the half line accumulator. (default)

Yadj\_delay [2:0]

- VS Bypass: VSYNC timing bypass
  - 0 = Normal operation (default). VS is derived from the sync separator or half line accumulator based on VS select, and the internal pixel/line counters. Register 35h can be used to adjust VSOUT alignment relative to HSOUT.
  - Bypass VSYNC processing. VSOUT is derived directly from the sync separator. VSOUT delay varies with sync separator threshold (register 11h). Register 35h has no effect.

# Blue Digital ALC Output LSBs

Subaddress	23h
Jubauuress	<b>Z</b> JI

Subaddress	23h						Read only	
7	6	5	4	3	2	1	0	
	Blue ALC Out [7:0]							

Blue ALC Out [7:0]: Eight LSBs of 10-bit filtered digital ALC output for Blue channel. The corresponding two MSBs are located at subaddress 27h. With the internal ALC loop enabled, the ADC dynamic range can be maximized by adjusting the coarse offset settings based on the ALC read back values. See registers 1Eh-20h for analog coarse offset control. If large adjustments are made to the analog coarse offset control, adequate time must be allowed for the ALC to converge prior to reading of this register. ALC delay requirements depend on the ALC NSV filter settings and the video input line rate. A delay of 30ms should be adequate for a 480i input with an NSV setting of 1/64. ALC NSV filtering can be increased following final coarse offset adjustment. See Reg28h for more information on ALC filter settings. Twos-complement value.

ALC Out[9:0] = ADC output - 512

For bottom-level clamped inputs (YRGB):

- Target ADC output blank level = 32 to avoid bottom level clipping at ADC ALC Out[9:0] = 32 - 512 = -480 = 220h
- Starting from positive offset, decrement YRGB coarse offset until ALC Out [9:0] ≤ 220h For mid-level clamped inputs (PbPr):
- Target ADC output blank level = 512 ALC Out[9:0] = 512 - 512 = 0
- Starting from positive offset, decrement PbPr coarse offset until ALC Out  $[9:0] \le 0$ .

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FXAS

Default (08h) 0

VS Bypass



Dood only

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#### Green Digital ALC Output LSBs

Subaddress	24h	

Subauuress	2411						Read Only	
7	6	5	4	3	2	1	0	
Green ALC Out [7:0]								

Green ALC Out [7:0]: 8 LSBs of 10-bit filtered digital ALC output for Green channel. The LSB of this 10-bit value is equivalent to the LSB of the 10-bit ADC. The corresponding two MSBs are located at subaddress 27h. Twos-complement value.

### Red Digital ALC Output LSBs

Subaddress	25h						Read only
7	6	5	4	3	2	1	0
Red ALC Out [7:0]							

Red ALC Out [7:0]: 8 LSBs of 10-bit filtered digital ALC output for Red channel. The LSB of this 10-bit value is equivalent to the LSB of the 10-bit ADC. The corresponding two MSBs are located at subaddress 27h. Twos-complement value.

#### Automatic Level Control Enable

Subaddress	26h						Default (80h)
7	6	5	4	3	2	1	0
ALC enable				Reserved			

ALC enable: Active-high automatic level control (ALC) enable

0 = ALC disabled

1 = ALC enabled (default)

See the ALC Placement register located at subaddress 31h.

## **Digital ALC Output MSBs**

Subaddress 27h Re								
7	6	5	4	3	2	1	0	
Res	erved	Red ALC	Out [9:8]	Green AL	C Out [9:8]	Blue ALC	Out [9:8]	

Red ALC Out [9:8]: 2 MSBs of 10-bit filtered digital ALC output for Red channel. The LSB of this 10-bit value is equivalent to the LSB of the 10-bit ADC. The corresponding eight LSBs are located at subaddress 25h. Twos-complement value.

Green ALC Out [9:8]: 2 MSBs of 10-bit filtered digital ALC output for Green channel. The LSB of this 10-bit value is equivalent to the LSB of the 10-bit ADC. The corresponding eight LSBs are located at subaddress 24h. Twos-complement value.

Blue ALC Out [9:8]: 2 MSBs of 10-bit filtered digital ALC output for Blue channel. The LSB of this 10-bit value is equivalent to the LSB of the 10-bit ADC. The corresponding eight LSBs are located at subaddress 23h. Twos-complement value.

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#### **Automatic Level Control Filter**

7	6	5	4	3	2	1	Default (53 0
Reserved		NSV	′ [3:0]	L		NSH [2:0]	
NSV [3:0]: ALC	vertical filter coeff	icient. First-order i	ecursive filter co	efficient. ALC upda	ates once per video	line.	
- [] -	NSV [3:0]	Descri					
00	100 = 1			verges in one iter	ation (i.e., one video	line)	
00	01 = 1/2						
00	10 = 1/4						
00	11 = 1/8						
01	00 = 1/16						
01	01 = 1/32						
01	10 = 1/64						
01	11 = 1/128						
10	00 = 1/256						
10	01 = 1/512						
10	10 = 1/1024 (defa	ault) Slowes	t setting. Provide	s the most filtering	<b>]</b> .		
10	11 = 1/1024						
11	00 = 1/1024						
11	01 = 1/1024						
11	10 = 1/1024						
11	11 = 1/1024						
↓SH [2:0]: ALC	c horizontal sample	filter coefficient. N	/lulti-tap running	average filter coef	ficient.		
	NSH [2:0]	Descri	otion				
0	1/2 = 1/2	2-tap ru	inning average fil	ter			
0	1001 = 1/4						
0	10 = 1/8						
0	011 = 1/16 (default	t)					
1	00 = 1/32						
1	01 = 1/64						
1	10 = 1/128						
1	11 = 1/256	256-tap	running average	e filter			



Default (07h)

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#### **Fine Clamp Control**

Subaddress	2Ah
------------	-----

Deladeress ZAI								Delault (0711)
	7	6	5	4	3	2	1	0
	CM Offset	Rese	erved	Fine sw	rsel [1:0]	Reserved	Fine GB	Fine R

CM Offset: Fine bottom-level clamp common mode offset enable. The common mode offset is approximately 300 mV when enabled. Has no effect when the coarse clamp or fine mid-level clamp is selected. See registers 10h and 2Dh.

0 = Common mode offset disabled (default)

1 = Common mode offset enabled

Reserved [6:5]:

0 = Normal operation (default)

Fine swse [1:0]I: Fine clamp time constant adjustment

00 = Longest time constant (default)

11 = Shortest time constant

Reserved [2]:

1 = Normal operation (default)

Fine GB: Active-high fine clamp enable for Green and Blue channel

0 = Green channel fine clamp disabled

1 = Green and Blue channel fine clamps enabled (default)

Fine R: Active-high fine clamp enable for Red channel

0 = Red channel fine clamp disabled

1 = Red channel fine clamp enabled (default)

NOTE: Leave Fine GB and Fine R bits turned on for proper clamp operation. See register 10h for mid and bottom level clamping control.

## **Power Control**

Subaddress 2Bh							(Default 00h)
7	6	5	4	3	2	1	0
Reserved	SOG	SLICER	REF	CURRENT	PW ADC B	PW ADC G	PW ADC R

SOG:

Slicer:

- 0 = Normal operation (default) 1 = SOG power-down
- 1 = 300 power-

0 = Normal operation (default)

1 = Slicer power-down

Reference:

0 = Normal operation (default)

1 = Reference block power-down

Current control:

0 = Normal operation (default)

1 = Current control block power-down

PW ADC B: Active-high power-down for ADC Blue channel

- 0 = ADC Blue channel power-down disabled (default)
- 1 = ADC Blue channel power-down enabled
- PW ADC G: Active-high power-down for ADC Green channel
  - 0 = ADC Green channel power-down disabled (default)
  - 1 = ADC Green channel power-down enabled
- PW ADC R: Active-high power-down for ADC Red channel
  - 0 = ADC Red channel power-down disabled (default)
  - 1 = ADC Red channel power-down enabled

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# ADC Setup

Subaddress	2Ch						(Default 50h)	
7	6	5	4	3	2	1	0	
ADC bias control [3:0]				Trim clamp [3:0]				

ADC bias control [3:0]: Allows adjusting the internal ADC bias current for optimum performance. In general, lower settings provide better ADC linearity while higher settings allow higher speed operation.

0h = Minimum setting

5h = Recommended setting (default)

Fh = Maximum setting

see bias current control for ADC reference amplifier at subaddress 3Eh.

Trim clamp [3:0]: SOG coarse clamp bias current control.

 $0h = 2 \mu A$  (default)

3h = 8 µA

Fh = 32 µA

 $IBIAS = 2 + 2 \times NBIAS$ , where  $0 \le NBIAS \le 15$ 

The SOG coarse clamp leakage current (subaddress 30h) is derived from the SOG coarse clamp bias current.

## Coarse Clamp Control

#### Subaddress 2Dh

7	6	5	4	3	2	1	0	
CCCLP_cur_CH1 [1:0]			Reserved [5:3]		Coarse B	Coarse G	Coarse R	

CCCLP\_cur\_CH1 [1:0]: Coarse clamp charge current switch selection.

00 = Highest charge current setting (default)

11 = Lowest charge current setting

Reserved [5:3]: RGB channel clamp down switch control

000 = Required setting (default)

Coarse B: Active-high coarse clamp enable for Blue channel

0 = Blue channel coarse clamp disabled (default)

- 1 = Blue channel coarse clamp enabled
- Coarse G: Active-high coarse clamp enable for Green channel
  - 0 = Green channel coarse clamp disabled (default)
    - 1 = Green channel coarse clamp enabled

Coarse R: Active-high coarse clamp enable for Red channel

0 = Red channel coarse clamp disabled (default)

1 = Red channel coarse clamp enabled

NOTE: Enabling Coarse clamps disables Fine clamps and overrides Fine clamp enable settings in subaddress 2Ah.

### SOG Clamp

#### Subaddress 2Eh

oubuuul 000							(Boladit ooli)
7	6	5	4	3	2	1	0
SOG_CE	CCCLP_cu	r_SOG [1:0]			reserved		

SOG\_CE: Active-high SOG clamp enable.

0 = SOG clamp disabled

1 = SOG clamp enabled (default)

CCCLP\_cur\_SOG [1:0]: SOG coarse clamp charge current switch selection.

- 00 = Lowest charge current setting (default)
- 11 = Highest charge current setting

Reserved [4:0]:

0 = Normal operation (default)

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Default (00h)

(Default 80h)



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#### **RGB Coarse Clamp Control**

Subaddress	2Fh						(Default 8Ch)
7	6	5	4	3	2	1	0
Res	erved	RGB leakage [5:0]					

RGB leakage [5:0]: RGB channel coarse clamp leakage current switch. Increasing the coarse clamp leakage current increases horizontal droop but improves hum rejection.

00h = 0.5 µA

 $0Ch = 6.5 \ \mu A \ when \ IBIAS = 2 \ \mu A \ (default)$ 

 $3Fh = 32.0 \ \mu A \ when \ IBIAS = 2 \ \mu A$ 

Droop\_Current = 0.5 + (IBIAS/4) × N<sub>DC</sub>, where  $0 \le N_{DC} \le 63$ 

#### **SOG Coarse Clamp Control**

Subaddress	30h						(Default 04h)
7	6	5	4	3	2	1	0
Reserved		SOG leal	kage [5:0]				

SOG leakage [5:0]: SOG coarse clamp leakage current switch. The SOG coarse clamp leakage current is derived from the bias current. Increasing the coarse clamp leakage current increases horizontal droop but improves hum rejection.

 $00h = 0.01 \ \mu A$ 

 $04h = 0.21 \ \mu A \ when \ IBIAS = 2 \ \mu A \ (default)$ 

 $3Fh = 3.16 \ \mu A \ when \ IBIAS = 2 \ \mu A$ 

Droop\_Current =  $(0.01 + (IBIAS/40) \times N_{DC}, \text{ where } 0 \le N_{DC} \le 63$ 

NOTE: IBIAS is controlled using Trim clamp [3:0] at subaddress 2Ch.

#### **ALC Placement**

Subaddress	31h						(Default 5Ah)			
7	6	5	4	3	2	1	0			
	ALC placement [7:0]									

ALC placement [7:0]: Positions the ALC signal an integer number of clock periods after either the leading edge or the trailing edge (default) of the HSYNC signal. Bit 3 of subaddress 15h allows selecting which edge of HSYNC is used as the timing reference for ALC placement. The ALC must be applied after the end of the fine clamp interval.

00h = Minimum setting

18h = PC graphics and SDTV with bi-level syncs

5Ah = HDTV with tri-level syncs (default)

#### Reserved

Subaddress	32h						Default (18h)		
7	6	5	4	3	2	1	0		
	Reserved [7:0]								

macvis thr [7:0] 8-bit Macrovision detection threshold

18h = Required setting (default)

#### Reserved

Subaddress	33h						Default (60h)		
7	6	5	4	3	2	1	0		
Reserved									

tsp\_thr [7:0]: 8-bit short pulse counter reset threshold. The Sync Processing block is reset whenever the number of coinsecutive short pulses exceeds the specified threshold.

60h = Required setting (default)



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#### Macrovision Stripper Width

#### 246

Subaddress	340						Delault (03h)			
7	6	5	4	3	2	1	0			
	stripper width [7:0]									

stripper width [7:0]: 8-bit Macrovision stripper width

00h = Minimum Macrovision stripper width

03h = (default)

FFh = Maximum Macrovision stripper width

When the MAC\_EN bit in Reg 22h is set to 1, this setting creates a stripper window around HSYNC for masking Macrovision pseudo-syncs or glitches that could affect PLL lock. The actual stripper width is determined from the stripper width [7:0] setting and can be approximated by 2 x stripper width [7:0] x REFCLK period. If set too low, stripper width [7:0] can adversely affect fine clamp and ALC placement. Reg 3Bh can be used for read-back of the HSYNC width for automation of this setup. To ensure proper operation of fine clamp and ALC, a minimum stripper width[7:0] setting of Reg 3Bh (HSYNC width) + Reg 3Dh (Line Length Tolerance) can be used. The maximum width is determined from the start of the Macrovision pseudo-syncs and the video input line length. Stripper width [7:0] settings exceeding one half of the input video line length cannot be used. Recommended settings for the more common formats are shown below for a Line Length Tolerance setting of 3. Stripper width [7:0] has no effect, when the MAC\_EN bit in Reg 22h is set to 0.

#### Table 16. Recommended Stripper Width Settings

VIDEO STANDARD	INTERNAL REFCLK USED	EXTERNAL 27-MHZ REFCLK USED
480i and 576i	24h	83h
480p and 576p	12h	43h
720p	07h	12h
1080i	07h	13h

#### **VSYNC Alignment**

Subaddress	35h						Default (10h)		
7	6	5	4	3	2	1	0		
	VS-HS Align [7:0]								

VS-HS Align [7:0]: Specifies the number of pixels that the leading edge of the VSYNC output should be delayed or advanced relative to the leading edge of the HSYNC output. The Field ID output is delayed by the same amount. Twos-complement number. This register has no effect when either Sync bypass mode is enabled (see subaddresses 22h and 36h).

00h-7Fh = VSYNC leading edge delayed relative to the HSYNC leading edge

FFh-80h = VSYNC leading edge advanced relative to the HSYNC leading edge

# Sync Bypass

#### Subaddross 364

Subaddress	36h						Default (00h)
7	6	5	4	3	2	1	0
	Reserved				HS INV	VS BP	HS BP

VS INV: VSYNC output polarity control. This bit only has an effect if the VSYNC bypass is asserted (bit 1 = 1).

0 = HSYNC output polarity matches input polarity (default)

1 = HSYNC output polarity inverted

HS INV: HSYNC output polarity control. This bit only has an effect if the HSYNC bypass is asserted (bit 0 = 1).

0 = HSYNC output polarity matches input polarity (default)

1 = HSYNC output polarity inverted

VS BP: VSYNC bypass. This bit enables bypassing the Sync processing block in order to output a raw unprocessed VSYNC.

0 = Normal operation (default)

1 = VSYNC bypass mode. Can be used with PC graphics having a discrete VSYNC input.

HS BP: HSYNC bypass. This bit enables bypassing the Sync processing block in order to output a raw unprocessed HSYNC.

0 = Normal operation (default)

1 = HSYNC bypass mode. Can be used for sync detection but is not recommended for normal operation

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#### Lines Per Frame Status

Subaddress	37h–38h							Read only	
Subaddress	7	6	5	4	3	2	1	0	
37h		Lines per Frame [7:0]							
38h	Reserved	mac detect	P/I detect	Reserved	Lines per Frame [11:8]				

mac detect: Macrovision pseudo-sync detection status

0 = Macrovision not detected

1 = Macrovision detected

P/I detect: Progressive/interlaced video detection status. Not dependent on the H-PLL being locked.

0 = Interlaced video detected

1 = Progressive video detected

Lines per Frame [11:0]: Number of lines per frame.

The lines per frame value may be used along with the clocks per line value (subaddresses 39h-3Ah) to determine the vertical frequency ( $f_V$ ) of the video input.

 $f_V$  = clock reference frequency / clocks per line / lines per frame

NOTE: The Lines per Frame counter is not dependent on the H-PLL being locked.

#### Table 17. Expected Status Read-Back When Using a 27-MHz REFCLK

Format	Clocks Per Line	Lines Per Frame	HSYNC Width	I/P Bit	HS POL	HS POL
480i60Hz	1716	525	126	0	1	1
480p60Hz	858	525	63	1	1	1
576i50Hz	1728	625	126	0	1	1
576p50Hz	864	625	63	1	1	1
720p60Hz	600	750	14	1	1	1
1080i60Hz	800	1125	16	0	1	1
XGA60Hz	558	806	56	1	0	0
XGA75Hz	449	800	32	1	1	1

#### **Clocks Per Line Status**

Subaddress	39h–3Ah							Read only		
Subaddress	7	6	5	4	3	2	1	0		
39h		Clocks per Line [7:0]								
3Ah		Rese	erved			Clocks per	Line [11:8]			

Clocks per Line [11:0]: Number of clock cycles per line. The value written to this register represents the length of the longest line per frame. A known timing reference based on either the internal clock reference (~6.5 MHz) or an external clock reference input (EXT\_CLK) of up to 27 MHz may be selected using subaddress 1Ah.

The clocks per line value may be used to determine the horizontal frequency  $(f_H)$  of the video input.

 $f_{H}$  = clock reference frequency / clocks per line

NOTE: The Clocks per Line counter is not dependent on the H-PLL being locked.

#### **HSYNC Width**

Subaddress	3Bh						Read only
7	6	5	4	3	2	1	0
			HSYNC \	width [7:0]			

HSYNC width [7:0]: Number of clock cycles between the leading and trailing edges of the HSYNC input. A known timing reference based on either the internal clock reference (~6.5 MHz) or an external clock reference input (EXT\_CLK) of up to 27 MHz may be selected using subaddress 1Ah.

NOTE: The HSYNC width counter is not dependent on the H-PLL being locked.

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#### VSYNC Width

Subaddress	3Ch						Read only
7	6	5	4	3	2	1	0
	Reserved			,	VSYNC width [4:0	]	

VSYNC width [4:0]: Number of lines between the leading and trailing edges of the VSYNC input. The VSYNC width along with the HSYNC and VSYNC polarities can be used to determine whether the input graphics format is using VESA-CVT generated timings. NOTE: The VSYNC width counter is not dependent on the H-PLL being locked.

## Line Length Tolerance

Subaddress	3Dh						Default (03h)
7	6	5	4	3	2	1	0
Reserved			Line	e length tolerance	[6:0]		

Line length tolerance [6:0]: Controls sensitivity to HSYNC input stability when using either the internal or external clock reference. Increased line length tolerance settings may be required for input signals having horizontal instability. This setting may affect the precision of the clock cycles per line counter (see subaddresses 39h–3Ah)

00h = (minimum) tolerance

03h = (default) tolerance

06h = (recommended) tolerance

7Fh = (maximum) tolerance

#### **ADC Reference Setup**

Subaddress	3Eh						Default (04h)
7	6	5	4	3	2	1	0
	Rese	erved			Ref bias c	ontrol [3:0]	

Ref bias control [3:0]: Bias current control for ADC reference amplifier.

0h = Minimum setting

4h = Required (default)

Fh = Maximum setting

See bias current control for ADC at subaddress 2Ch.

#### Video Bandwidth Control

Subaddress	3Fh						Default (00h)
7	6	5	4	3	2	1	0
	Rese	erved			BW sel	ect [3:0]	

BW select [3:0]: Selectable low-pass filter settings for controlling the analog video bandwidth. This control affects the analog video bandwidth of all three ADC channels.

0h = Highest video bandwidth (default)

Fh = Lowest video bandwidth (~90 MHz analog video bandwidth )

NOTE: This filter setting can be used to filter high frequency noise, but the filter lacks the precision for maximum filtering of s video formats. The lowest bandwidth setting provides a video bandwidth of at least 50 MHz.

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Default (05h)

# AVID Start Pixel

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Subaddress	40h–41h							Default (012Ch)
Subaddress	7	6	5	4	3	2	1	0
40h				AVID s	tart [7:0]			
41h	Reserved AVID active AVID start [12:8]							

AVID active

0 = AVID out active during VBLK (default)

1 = AVID out inactive during VBLK

AVID start [12:0]: AVID start pixel number, this is an absolute pixel location from the leading edge of HSYNC (start pixel 0). The TVP70025I updates the AVID start only when the AVID start MSB byte is written to.

AVID start pixel register also controls the position of SAV code. The TVP70025I inserts the SAV code four pixels before the pixel number specified in the AVID start pixel register.

#### **AVID Stop Pixel**

Subaddress	42h–43h						Γ	Default (062Ch)	
Subaddress	7	6	5	4	3	2	1	0	
42h		AVID stop [7:0]							
43h		Reserved		AVID stop [12:8]					

AVID stop [12:0]: AVID stop pixel number. The number of pixels of active video must be an even number. This is an absolute pixel location from the leading edge of HSYNC (start pixel 0).

The TVP70025I updates the AVID Stop only when the AVID Stop MSB byte is written to.

AVID stop pixel register also controls the position of EAV code.

#### **VBLK Field 0 Start Line Offset**

Subaddress	44h							Default (05h)
Subaddress	7	6	5	4	3	2	1	0
44h				VBLK sta	art 0 [7:0]			

VBLK start 0 [7:0]: VBLK start line offset for field 0 relative to the leading edge of VSYNC. The VBLK start line offset value affects the location of transitions on the embedded sync V-bit and VBLK of the Data Enable output, but not the VSYNC output (VSOUT). The VSYNC output simply follows the VSYNC input. Unsigned integer.

#### VBLK Field 1 Start Line Offset

#### Subaddress 45h

Oubuuurcoo	4011							Delaut (0011)
Subaddress	7	6	5	4	3	2	1	0
45h				VBLK sta	art 1 [7:0]			

VBLK start 1 [7:0]: VBLK start line offset for field 1 relative to the leading edge of VSYNC. The VBLK start line offset value affects the location of transitions on the embedded sync V-bit and VBLK of the Data Enable output, but not the VSYNC output (VSOUT). The VSYNC output simply follows the VSYNC input. Unsigned integer.

#### **VBLK Field 0 Duration**

Subaddress	46h							Default (1Eh)
Subaddress	7	6	5	4	3	2	1	0
46h				VBLK dura	tion 0 [7:0]			

VBLK duration 0 [7:0]: VBLK duration in lines for field 0.

#### **VBLK Field 1 Duration**

Subaddress	47h							Default (1Eh)	
Subaddress	7	6	5	4	3	2	1	0	
47h		VBLK duration 1 [7:0]							

VBLK duration 1 [7:0]: VBLK duration in lines for field 1.

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# F-bit Field 0 Start Line Offset

Subaddress	48h							Default (00h)
Subaddress	7	6	5	4	3	2	1	0
48h		F-bit start 0[7:0]						

F-bit start 0 [7:0]: F-bit Field 0 start line offset relative to the leading edge of VSYNC, signed integer, set F-bit to 0 until field 1 start line, it only applies in interlaced mode. For a non-interlace mode, F-bit is always set to 0.

NOTE: The field ID output (FIDOUT) is always aligned with the leading edge of the VSYNC output (VSOUT).

# F-bit Field 1 Start Line Offset

Subaddress	49h							Default (00h)	
Subaddress	7	6	5	4	3	2	1	0	
49h		F-bit start 1 [7:0]							

F-bit start 1 [7:0]: F-bit Field 1 start line offset relative to the leading edge of VSYNC, signed integer, set F-bit to 1 until field 0 start line, it only applies in interlaced mode. For a non-interlace mode, F-Bit is always set to 0.

NOTE: The field ID output (FIDOUT) is always aligned with the leading edge of the VSYNC output (VSOUT).

### 1st CSC Coefficient

Subaddress	4Ah–4Bh						[	Default (16E3h)		
Subaddress	7	6	5	4	3	2	1	0		
4Ah		1st Coefficient [7:0]								
4Bh		1st Coefficient [15:8]								

1st Coefficient [15:0]: 16-bit G' coefficient MSB for Y

# 2nd CSC Coefficient

Subaddress	4Ch–4Dh							Default (024Fh)		
Subaddress	7	6	5	4	3	2	1	0		
4Ch		2nd Coefficient [7:0]								
4Dh		2nd Coefficient [15:8]								

2nd Coefficient [15:0]: 16-bit B' coefficient MSB for Y

#### 3rd CSC Coefficient

Subaddress	4Eh–4Fh						E	Default (06CEh)		
Subaddress	7	6	5	4	3	2	1	0		
4Eh		3rd Coefficient [7:0]								
4Fh		3rd Coefficient [15:8]								

3rd Coefficient [15:0]: 16-bit R' coefficient MSB for Y

#### 4th CSC Coefficient

Subaddress	50h–51h						C	Default (F3ABh)		
Subaddress	7	6	5	4	3	2	1	0		
50h		4th Coefficient [7:0]								
51h		4th Coefficient [15:8]								

4th Coefficient [15:0]: 16-bit G' coefficient MSB for U



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## **5th CSC Coefficient**

Subaddress	52h–53h							Default (1000h)		
Subaddress	7	6	5	4	3	2	1	0		
52h		5th Coefficient [7:0]								
53h		5th Coefficient [15:8]								

5th Coefficient [15:0]: 16-bit B' coefficient MSB for U

#### **6th CSC Coefficient**

#### 546 554 Subaddra

Subaddress	54h–55h						I	Default (FC55h)		
Subaddress	7	6	5	4	3	2	1	0		
54h		6th Coefficient [7:0]								
55h	6th Coefficient [15:8]									

6th Coefficient [15:0]: 16-bit R' coefficient MSB for U

#### 7th CSC Coefficient

Subaddress	56h–57h						I	Default (F178h)		
Subaddress	7	6	5	4	3	2	1	0		
56h		7th Coefficient [7:0]								
57h	7th Coefficient [15:8]									

7th Coefficient [15:0]: 16-bit G' coefficient MSB for V

# 8th CSC Coefficient

Subaddress	58h–59h						Γ	Default (FE88h)		
Subaddress	7	6	5	4	3	2	1	0		
58h		8th Coefficient [7:0]								
59h		8th Coefficient [15:8]								

8th Coefficient [15:0]: 16-bit B' coefficient MSB for V

#### 9th CSC Coefficient

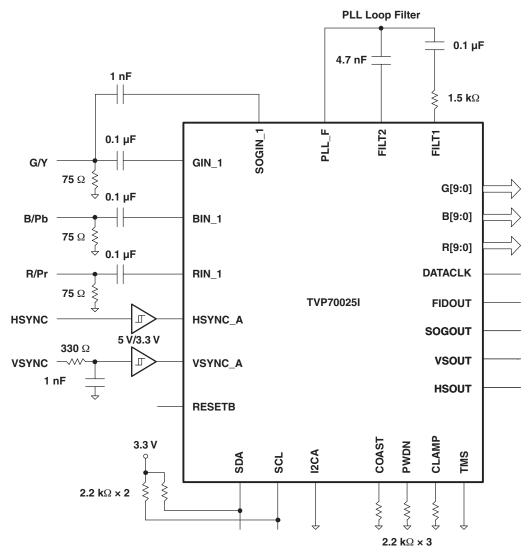
Subaddress	5Ah–5Bh						I	Default (1000h)	
Subaddress	7	6	5	4	3	2	1	0	
5Ah	9th Coefficient [7:0]								
5Bh	9th Coefficient [15:8]								

9th Coefficient [15:0]: 16-bit R' coefficient MSB for V

TEXAS INSTRUMENTS

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**APPLICATION INFORMATION** 

NOTE: System level ESD protection is not shown in this application circuit but is highly recommended on the RGB and H/VSYNC inputs.

Figure 8.	<b>TVP70025I</b> Application Example
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STRUMENTS

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# **REVISION HISTORY**

REVISION	COMMENTS								
SLES232	Initial release								
SLES232A	Table 1. Terminal Functions, Modified I2CA pin description.Functional Description, Modified supported formats section.Reset and I2C Bus Address Selection, Modified I2CA description and Table 7.								
SLES232B	Modified Supported Formats and Sync Separator sections.								
	Added format detection information to the Control Register section. Added sync separator information to the Control Register section.								
	Modified the Output Timing Information in Table 6. Added information to the Embedded Syncs section.								
SLES232C	Made editorial changes throughout.         Table 5, Standard: Video, Resolution: 720 x 480i: Changed Line Rate (kHz) from 15.374 to 15.734.								
	Table 5, Standard: Video, Resolution: 1920 x 1080i: Changed Frame Rate (Hz) from 60 to 30 and from 50 to 25.								



31-May-2013

# **PACKAGING INFORMATION**

Orderable Device	Status	Package Type	Package	Pins	Package	Eco Plan	Lead/Ball Finish	MSL Peak Temp	Op Temp (°C)	Device Marking	Samples
	(1)		Drawing		Qty	(2)		(3)		(4/5)	
TVP70025IPZP	NRND	HTQFP	PZP	100	90	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-3-260C-168 HR	-40 to 85	TVP70025I	
TVP70025IPZPR	NRND	HTQFP	PZP	100	1000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-3-260C-168 HR	-40 to 85	TVP70025I	

<sup>(1)</sup> The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

**NRND:** Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

**PREVIEW:** Device has been announced but is not in production. Samples may or may not be available.

**OBSOLETE:** TI has discontinued the production of the device.

(2) Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS), Pb-Free (RoHS Exempt), or Green (RoHS & no Sb/Br) - please check http://www.ti.com/productcontent for the latest availability information and additional product content details.

**TBD:** The Pb-Free/Green conversion plan has not been defined.

**Pb-Free (RoHS):** TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes. **Pb-Free (RoHS Exempt):** This component has a RoHS exemption for either 1) lead-based flip-chip solder bumps used between the die and package, or 2) lead-based die adhesive used between

the die and leadframe. The component is otherwise considered Pb-Free (RoHS compatible) as defined above.

Green (RoHS & no Sb/Br): TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

<sup>(3)</sup> MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

<sup>(4)</sup> There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.

(5) Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.

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PZP (S-PQFP-G100)

PowerPAD™ PLASTIC QUAD FLATPACK



NOTES: A. All linear dimensions are in millimeters.

B. This drawing is subject to change without notice.

C. Body dimensions do not include mold flash or protrusion

D. This package is designed to be soldered to a thermal pad on the board. Refer to Technical Brief, PowerPad Thermally Enhanced Package, Texas Instruments Literature No. SLMA002 for information regarding recommended board layout. This document is available at www.ti.com <a href="http://www.ti.com">www.ti.com</a>.

E. See the additional figure in the Product Data Sheet for details regarding the exposed thermal pad features and dimensions. F. Falls within JEDEC MS-026

PowerPAD is a trademark of Texas Instruments.



# PZP (S-PQFP-G100)

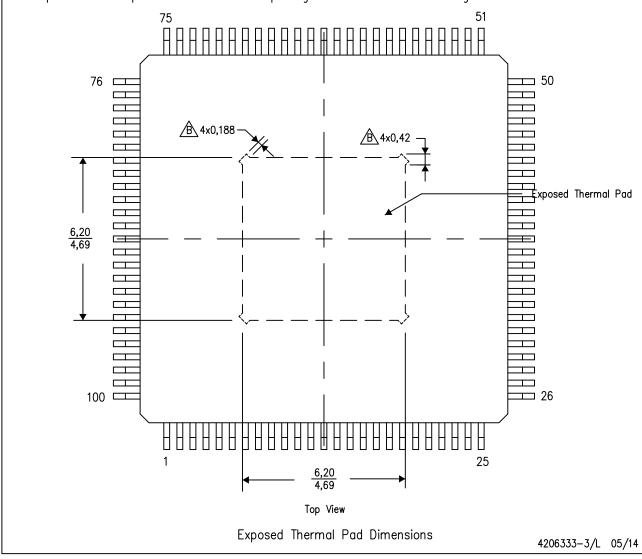
# PowerPAD<sup>™</sup> PLASTIC QUAD FLATPACK

# THERMAL INFORMATION

This PowerPAD<sup>™</sup> package incorporates an exposed thermal pad that is designed to be attached to a printed circuit board (PCB). The thermal pad must be soldered directly to the PCB. After soldering, the PCB can be used as a heatsink. In addition, through the use of thermal vias, the thermal pad can be attached directly to the appropriate copper plane shown in the electrical schematic for the device, or alternatively, can be attached to a special heatsink structure designed into the PCB. This design optimizes the heat transfer from the integrated circuit (IC).

For additional information on the PowerPAD package and how to take advantage of its heat dissipating abilities, refer to Technical Brief, PowerPAD Thermally Enhanced Package, Texas Instruments Literature No. SLMA002 and Application Brief, PowerPAD Made Easy, Texas Instruments Literature No. SLMA004. Both documents are available at www.ti.com.

The exposed thermal pad dimensions for this package are shown in the following illustration.



NOTE: A. All linear dimensions are in millimeters

 $\cancel{B}$  Tie strap features may not be present. PowerPAD is a trademark of Texas Instruments



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